

TENDER DOCUMENTS

Procurement of Innovation Lab

NUTECH / SCM /Innovation Lab 2021 / TD-216

NATIONAL UNIVERSITY OF TECHNOLOGY

TENDER & CANCELLATION NOTICE

National University of Technology (NUTECH)

NUTECH / SCM /Innovation Lab/TD-216

Note: NUTECH / SCM /Innovation Lab/TD-211 Stand Cancelled

1. Sealed bids are invited from Government / FBR Registered Firms for the procurement on **FOR Basis**.

2 Tender documents containing terms, conditions and detailed specifications of items (including draft contract) can be downloaded from NUTECH website "<u>https://nutech.edu.pk/downloads/procurement/scm-tenders/</u>" w.e.f **28 April 2021**.

3. Quotations shall be submitted as per requirement of the tender documents.

4. Bidders will be required to submit **Bank Draft / CDR** equal to **5%** of quoted value as Bid Bond in favor of National University of Technology (NUTECH).

5. <u>Submit Rs 1500/- as Tender fee in favor of NUTECH HBL Account (NUTECH</u> <u>Tendering and Contracts. 5037-7000210755).</u> Please attach bank receipt with technical offer. Offers will not be entertained without payment of processing fee.

6. Details for Submission & Opening of bids for tender are as under: -

Ser	Description	Submission	Tender Opening	Completion Days
d.	Innovation Lab (TD-211)	1030 hrs on 28 Apr 2021	1100 hrs on 28 Apr 2021	60 Days

Deputy Director (Supply Chain Management)

NATIONAL UNIVERSITY OFTECHNOLOGY, IJPROAD, I-12, ISLAMABAD

Tel: 0092-51-5476768, Ext: 278

NATIONAL UNIVERSITY OF TECHNOLOGY SUPPLY CHAIN MANAGEMENT INVITATION TO TENDER

Tender submission time: 1030 hrs on 28 April 2021

1. NUTECH desires to procure the list of item(s) / Store(s) on <u>FOR</u> <u>**b** a s i s</u> as per Annexure-A. Interested bidders are requested to send their bids through courier or deliver at NUTECH under "<u>Single Stage – Two Envelopes</u>" (two <u>envelopes placed together in third envelope</u>), marked clearly as "Technical <u>Offer" and "Commercial Offer</u>" respectively to the undersigned, latest by or before above mentioned due date.

2 **<u>Conditions Governing Contracts.</u>** The contract made as result of this IT will be in accordance with the draft contract published on NUTECH University website and other special conditions (Mentioned in this document) that may be added to given contract for the supply of Lab Equipment.

3. Delivery of Tender. The offer is to be submitted as under:-

- a. <u>Technical Offer.</u> Technical Offer should contain only Annexure-A, Annexure-A-1 & Annexure B duly filled in (supported with relevant technical literature / details / catalogues etc) and receipt of tender processing fee. Copy of bid bond WITHOUT MENTIONING PRICE should be attached with technical offer. Only relevant technical details i.e literature/brochures) without mentioning the financial aspect of the offer in DUPLICATE should be enclosed in an envelope. In technical proposal, all items must have the brand names, model number, manufacturer's name, country of origin, manufacturer's warranty including parts with complete specs and brochures. Re-conditioned and re-furbished equipment shall not be acceptable. Following information will be clearly marked on the envelope:
 - (1) Technical Offer
 - (2) Original Performa Invoice (without price)
 - (3) Tender number
 - (4) Date/ time of opening
- <u>Commercial Offer.</u> Commercial Offer will contain Annexure-C and bid bond (Dully mentioned and placed in separate envelope. The offer indicating the quoted price FE/Local Currency (in Local Currency for FOR cases & in FE for FOB cases) in figures as well as in words

would be enclosed in an envelope. Following information will be clearly marked on the envelope;

- (1) Commercial Offer
- (2) Original Performa invoice with price
- (3) Tender number
- c. Both the envelopes i.e. commercial offer and technical offer would be enclosed in yet another properly sealed envelope that will be marked with address of this office only. There should be clear indication that this envelope contains tender documents.
- d. The tender duly sealed will be addressed to the following:-

Deputy Director (Supply Chain Management Office) NATIONAL UNIVERSITY OF TECHNOLOGY (NUTECH) IJ P ROAD, I-12, ISLAMABAD Tel: 0092-51-5476768, Ext: 227

4. Date and Time for Receipt of Tender. Sealed bids with detailed specifications should reach SCM office latest by <u>1030 hrs on 28 April 2021</u>. Delay occurring in post shall not be accepted. Tenders received after the appointed / fixed time will NOT be entertained. The appointed time will, however, fall on next working day in case of closed / forced holiday.

5. <u>Tender opening.</u> The offers shall be opened **30 minutes** after submission time. Commercial offers will be opened at later stage if Technical Offer is found acceptable on examination by technical authorities. Date and time for opening of commercial offer shall intimated later. Only legitimate / registered representatives of firm will be allowed to attend tender opening.

6. <u>Validity of Offer.</u> The validity period of quotations must be indicated and should be **90 days** from the date of opening of financial offer.

7. <u>With drawal of offer</u> If the firm withdraws its offer within validity period, the competent authority may place such firm under <u>embargo for a period which may be</u> <u>extended up to one year</u>. <u>Moreover</u>, the Earnest Money of the firm will be <u>confiscated</u>.

8. **Documents.** Following information / copy of documents must be provided / attached with offer:-

- a. A copy of letter showing firm's financial capability.
- b. NTN/GST number be mentioned on the offer and copy of registration Certificate issued by Sales Tax Department, attached.

- **c.** Foreign supplier to provide its Registration Number issued by respective Department of Commerce authorizing export of subject stores (in FOB cases).
- d. Annexes A, A-1, B and C and special conditions must be signed and stamped. ATTACH ONLY RELEVANT DOCUMENTS.
- e. Complete all Annexes as per given format. Do not use your format or letter head. Offer may be rejected if given format is not followed.
- f. OEM/principal agency agreement must be provided.
- 9. **Disgualification.** Offers are liable to be rejected if:
 - a. Validity of offer is not quoted as required in IT documents.
 - b. Any deviation from the General/ Special / Technical Instructions.
 - c. Offers are found conditional or incomplete in any respect.
 - d. Copy of EM/Bid Bond & Tender processing fee (with tech offer) and original EM/Bid Bond (with fin offer) are NOT attached.
 - e. Manufacturer's relevant brochures and technical details on major equipment assemblies are not attached in support of specifications.
 - f. Offer received later than appointed / fixed date and time.
 - g. Subject to restriction of export license.
 - h. Offers (Commercial / technical) containing non-initialled / unauthenticated amendments / corrections / overwriting. If the validity of the agency agreement has expired. The commercial offer against FOB / CIF / C&F tender quoted in local currency.
 - i. If the offer is found to be based on cartel action in connivance with other sources/participants of the tender.

10. **Earnest Money / Bid Bond.** Commercial Offer must be accompanied with a Bid Bond (CDR/Pay Order/Bank Draft) in agreement of faithful compliance of the conditions of Contract. This amount will be equivalent to 5% of the total quoted value. The Bid Bond amount submitted by the successful bidder will however be refunded on effective termination of Contract. (The Bid Bond will be forfeited in case of default by the bidder from his commitments made through his offer). Submission of Bid Bond is mandatory; otherwise your offer will be rejected. Bid Bond will be used as performance guarantee till the delivery of stores, otherwise separate performance guarantee valued at 5 % of contract will be submitted by successful firm till stores are delivered and inspected.

11. Return of Earnest Money/Bid Bond.

- a. Bid Bond to the unsuccessful bidders will be returned on finalization of the lowest evaluated bidder.
- b. Bid Bond of the successful bidder/bidders will be returned on submission of Bank Guarantee/Bid bond against warranty period OR Bid bond retained for the warranty period as the case may be.

12 Terms of Payment/ LC Charges

(In FOB cases)

All categories payment will be made through letter of credit (LC). LC opening charges in Pakistan are to be borne by NUTECH. Payment will be made through irrevocable LC in favour of Manufacturer.

In FOR cases

- b. 50% payment will be paid in advance if demanded by the firm against CDR/BG/PO/DD/BC through cross cheque or inland LC.
- c. 50 % payment will be paid after installation, commissioning of the store through cross cheque or inland LC.

Or

d. 100% payment may be considered on delivery of the store through cross cheque or inland LC.

13. <u>Warranty/ Bank Guarantee (BG)</u>. 2 Years for serial (1 to 5,8,11 to 22, 27 to 43) against 5% Bank Guarantee/CDR/Pay Order/Bank Draft of the store value will be required from the successful bidders from the date of commissioning as performance bond. BG submitted shall remain valid for up to 60 days beyond completion of warranty period.

14. <u>Taxes/ Duties/ Custom clearance</u> All taxes /duties /import Licenses Fee as applicable under government laws in Pakistan as well as country of supplier shall be on Seller (in FOR Case). NUTECH will provide applicable exemption certificates and documents (In FOB Cases only).

15. <u>Insurance:</u> Insurance will be NUTECH's responsibility through NICL (in FOB Cases).

16. <u>Freight charges /Misc charges:</u> All charges such as packing, forwarding, local freight, loading and unloading, installation and commissioning, custom clearance, orientations, on job training or any other will be part of quoted price. Delivery till NUTECH will be seller's responsibility and all associated costs will be part of quotation as well.

17. **Delivery Schedule.** Store will be delivered within **60 days** from contract signing date.

18. **Force Majeure.** If non-compliance with the period of delivery or services can be proved to be due to Force Majeure, such as but not limited to mobilization, war, riot, strike, lockout, pandemics/epidemics or the occurrence of unforeseen events, the period shall be reasonably extended.

19. **Subletting** Suppliers are not allowed to sublet wholly or part of the contract to any other firm /company without prior permission by NUTECH. Firm found in breach of the clause will be dealt with as per purchaser's right and discretion.

20. Arbitration. Will be as under:-

"All Claims ,disputes ,controversies, differences arising out of or in connection with this contract ,including any question regarding its existence, validity, interpretation performance, breach or termination ,shall be referred to and shall finally be solved by binding arbitration. An Arbitration Committee Shall be constituted comprising Rector NUTECH and two Arbitration to be nominated on mutual agreement by each party. The venue of the Arbitration shall be the place of issuance of this contract or as Rector NUTECH may determine. In case of any difference, the clauses of Arbitration Act 1940, Rules and Regulation made thereof for time being enforce shall prevail. The award shall be final and binding on both parties.

- a. Provided that written record of any such arbitration and its award shall be arranged properly. An award of such arbitration may be confirmed in a court of competent jurisdiction at Islamabad.
- b. Provided further that incase of any other question /dispute not covered under this clause, the decision of Rector NUTECH shall be final."

21. **<u>Redress Of Grievance.</u>** In case of dispute, case shall be reviewed by 'NUTECH Redress of grievance committee and decision of NUTECH shall be final and binding on both parties.

22 **Export License/Permit /End User Cert.** It shall be the responsibility of the Supplier to obtain from the Government concerned all permits and export licenses, etc required to enable each consignment to be shipped immediately as per the delivery schedule. In case the supplier fails to arrange export license within 30 days of signing the contract the purchaser reserves the right to cancel the contract on the

risk and expense of the supplier without prior notice. The purchaser will provide End User Certificate for acquisition of export license to the supplier (format to be provided by the supplier for respective country within 10 day of signing of the contract).

23. <u>Technical Specification:</u> The supplier will provide OEM certificate, quality certificate /inspection document to the purchaser confirming the quality of the product being supplied under this contract .Store must bear the manufacturer's identification marking /monogram.

24. **Inspection /Testing of Store**: Inspection testing will be carried out at NUTECH by the concerned inspection team as detailed by the respective department in accordance with the laid down Acceptance Criteria. (Acceptance Test Procedure (ATPs)/Drawing /Test standard and specification). The supplier will provide ATPs with technical offer. Mutually agreed/approved ATPs will form part of contract to govern the inspection of store subsequently.

25. <u>Change In Specification / Mfr / Model.</u> No alternation marked/brand and quality of store will be entertained after the tender have been opened.

26. **Checking of Store at Consignee/User End.** All stores will be checked at Consignee's end in the presence of the supplier's representative. If for some reason, the supplier decides not to nominate his representative for such checking, an advance written notice to this effect will be given by the supplier to the consignee prior to immediately on shipment of store. In such an event the supplier will clearly undertake that decision of consignee with regard to quantities and description of consignment will be taken as final and discrepancy found will be accordingly made up by supplier. In all other cases the consignee will inform the supplier about arrival of consignment immediately on receipt of store through registered email/letter and telephone. If no response from the supplier is received within 15 days from initiation letter the consignee will have the right to proceed with the checking without supplier's representative. User/Consignee's report on checking of the stores will be binding on the seller in such cases.

27. **Packing /Marking.** The supplier shall be responsible for proper packing of the Store in standard export packing worthy of transportation by sea /air /road rail so as to ensure their content being free from lose or damages due to faulty packing on arrival at the ultimate destination. Packing of stores will be done at the expenses of the supplier. All packing cases, containers and other packing material shall become the property of the NUTECH on receipt. Any loss occurred /demurrage paid due to wrong marking will be made good by the supplier.

28. **Original Performa Invoice**: Original Performa invoice must have following components incorporated:-

- a. HS Code
- b. Incoterm
- c. Payment Terms
- d. Origin of good
- e. Port of shipment
- f. Address of OEM
- g. Seller acceptance (on Performa Invoice)
- h. Invoice Date
- i. Latest date of shipment
- j. Seller complete bank detail

Note: Performa Invoice in the name of NUTECH in case of FOB cases & in the name of local partner in case of FOR cases.

29. General Instructions: Following must be noted:-

- a. The firm should provide point to point acceptance of each clause of IT and special instructions attached with IT.
- b. Firm will render a certificate with technical offer that firm is neither defaulter nor blacklisted by any Government / semi Government organization directly or indirectly. (On Judicial Paper)
- c. Rates should be quoted on Free Delivery basis at NUTECH Islamabad.
- d. The stipulated delivery period should be strictly adhered to. Any anticipated delay that is beyond the control of Seller will be informed (in writing) well in advance of the expiry of the due date of the activity along with reasons thereof, requesting for the grant of extension in delivery period. If the Seller fails to do so, or the Buyer is not convinced with the rationale provided by the Seller, Liquidated Damages up to/at 2% per month or part thereof, will be imposed. However, the maximum limit of the Liquidated Damages will not exceed 10% of the delayed store value.
- e. If even after applicability of 10% LD, the Seller fails to deliver the required stores, the Buyer will be at liberty to Cancel the contract, and /or procure the stores from an alternate source, on the Seller's "Risk & Cost/Expense". In that case, the Seller will be bound to make payment to the new source through NUTECH. The purchaser's

decision under this clause shall NOT be subjected to arbitration.

- f. NUTECH reserves the right to cancel the Contract without assigning any reason whatsoever during its currency / execution / after placement, if the firm is found to be involved in any dubious activity, litigation, lacking to meet contractual obligations with the purchaser or is blacklisted with any other Public procurement agency. No claims / loss /damage of whatsoever nature shall be entertained and NUTECH's decision in this regard will be final / binding on the Seller.
- g. An appropriate amount may be paid for mobilization against Bank Guarantee/CDR/Demand Draft/Pay Order.
- Firms with previous pending/outstanding projects/business and unsatisfactory performance with NUTECH may not be considered for award of any further business.
- i. Lowest evaluated bidders must send their authorized representatives for signing of the contract within three days of sharing of the draft contract.
- j. For technical opening firm will send a representative who has knowledge about the quoted items otherwise representative will not be allowed to sit in tender opening.

Deputy Director Supply Chain Management Office

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<u>Annex-A</u>

Technical Specifications

NUTECH / SCM /Innovation Lab/TD-216

Ser	Part No	Items	Descriptio	on			A/U	Country of Origin	Qty Req	Bidder Compliance		Tech Sc to be by u	rutiny e done ser
										Yes	No	Accepted	Rejected
												Reason of	Rejection
1.		3D Scanner	 Time ne mode: 7 Plug-an calibrat Uses a other lig glasses Technical Scan Mode Scan Speed Mode of Alignment Single Shot Accuracy Maximum Scan Volume / Minimum Scan Volume / Minimum Scan Volume / Minimum Scan Volume / Minimum Scan Volume / Minimum Scan Volume / Minimum Scan Volume Range of Single Capture Point 	eeded for a eeded for a 1 minute ad-play. East ion safe struct ght sources specificat Auto scan 1 min. Feature; Manual ≤ 0.05 mm 200 x 200 x 200 mm / 30 x 30 x 30 mm 200 x 150 mm	single sca 360° scan sy set-up w ured white that requir ions (Minin Fixed scan 4 s Turntable ; Manual ≤ 0.05 mm 1200 x 1200 x 1	n: 4 seconds in Auto Scan vith automated light, no laser or re protection mum):	No	European / North American	1			Reason of	Rejection
1			Distance	mm ~ 0.2	mm ~ 0.2								

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											<u>,</u>	
				mm	mm							
			Texture	Yes	Yes							
			File	OBJ.	OBJ.							
			Format	STL.	STL.							
				ASC.	ASC.							
				PLY	PLY							
			Camera	1.3	1.3							
			Resolutio	Megapixe	Megapixe							
			n		1							
			Light	White	White							
			Source	Light	Light							
			Stand-off	290 ~	290 ~							
			Distance	480 mm	480 mm							
			Weight u	4.2 kg /	4.2 kg /							
			npacked /	7.0 kg	7.0 kg							
			packed	Ū								
			Dimensio	570 x 210	570 x 210							
			n	x 210 mm	x 210 mm							
			Power	50 W	50 W							
			Supply									
			Input	DC: 12 V	DC: 12 V							
			Voltage	/ 3.33 A	/ 3.33 A							
2.		3D Printer (SLA)	3D Printer	should be o	compatible	with 3rd party 3D	No	European	1			
		()	printing res	sins flexibili	tv to trv the	different type of		/ North				
			resin such	as castable	e resin tou	nh resin		American				
			biocompati	hle resin		gir room,		, anonoan				
			3D printor	should uso	the colf de							
			3D printer :		une sen-ue							
			ruoup resc	siulion light	engine, wr							
			more stable	e LED Inter	nsity and be	etter printing quality						
			Touch scre	en should	be available	e						
			Advanced	architecture	e main boa	rd and self-						
			developed	proprietary	Iight engin	e work together						
			perfectly. D	Dual-core 8	00 MHz AR	M processor						
			ensures hid	ah-perform	ance and b	etter user						
			experience	The main	board is de	signed and made						
			in a $10 law$	er high nree	cision hoar	a safequarding						
				ntogrity on	d the stabili	ty of the projection						
				megniy and								
			signal.									
1			TECHNICA	AL SPECIE	CATIONS	(winimum):						
			3D Printing	g DL	.P (Digital							ļ

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Technology	Light			
Drinting Size	Processing)			
Printing Size	$120 \times 67.5 \times 150$			
Z avia lavar				
∠ axis iayer	$25/50 \mu m$ (0.025			
	(0.0011111)			
X-Y axis	02.5 μm (0.0025			
	1000 pm 1 5 D:			
Light source	405 nm LED;			
2D Drinting	Spall ElechDrint			
Software	FIASHPHIN			
3D File formet				
	USB Cabla LISP			
Connectivity				
Printor	300 x 210 x 565			
dimonsions	500 X 510 X 505			
Drinter weight	17.9 kg			
	100 240v 50			
Power	100-240V, 50- 60Hz 1A			
	00HZ, IA			
	ECIFICATIONS (N	/inimum)·		
Build volume (in	1.215	anninanny.		
liters)				
Build volume (in	120 × 67.5 × 150			
millimeters)	mm			
Layer resolution	Z: 25 / 50			
	microns (0.025 /			
	0.05 mm) X-Y:			
	62.5 microns			
	(0.0625 mm)			
Print technology	Digital Light			
	Processing (405			
	nm LED with			
	50,000 hours life			
	span)			
CONNECTIVITY:				
USB	Yes			

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I I						1		1	-	
		Wi-Fi	Yes							
			· (• • • • • • • • • • • • • • • • • •							
		Product	360 X 310 X 565							
		Broduct weight	11111 17.9 kg							
			17.0 KY							
		SOFTWARE								
		File formats	STL							
		Included	FlashPrint							
		software								
						_				
3.	Digital Oscillosco	peTechnical Spec	ification (Minimum):	No	European	2			
		 10M sample s 	tandard and 20M sa	mple		/ North				
		interleaved				American				
		• 30000 to 5000	0 waveforms/s upda	ate rate						
		 100MHz dual 	channel							
		 Sensitivity dov 	vn to 1mV/div(2mV/	div)						
		 low noise 								
		 Math functions 	s such as + *. /. F	FT						
			, , , ,							
		OR Equivalent								
4.	Function	Technical Spec	ification (Minimum):	No	European	2			
	Conorator	Frequency range	e: 0.5 Hz5 MHz (si	ne); arbitrary		/ North				
	Generator	0.5 Hz5 MHz (or higher)			American				
		Waveforms: Sin	e, square/pulse, ram	p, white noise,						
		arbitrary (exp. ris	se/fall, sin(x)/x, stairo	ase etc.; 45						
		built-in signal an	d user definable arb	itrarv						
		waveforms)		,						
		OR Equivalent								
5.	Handheld Multi	Technical Spec	ification (Minimum):	No	European	4			
	Matar	• 0.05% basic a	ccuracy			/ North				
	Meter	True RMS	···- J			American				
		Auto power of	f							
		Auto power of	f							

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		 Overload protection DC ranges: 0.1 mV to 1000 V Resolution:10 μV to 100 mV AC ranges: 200 mV- 2 V, 20 V- 750 V (or higher) Fuse for short circuit protection OR Equivalent				
6.	Workstation	Work Station (Size6'x2'x6')	No	Local/	4	_
	(3 Level	 Wooden with metallic base (pipe size 1.5 inches) 		Imported		
	Adjustable)	 Power Sockets and additional accessories are not required. Just 3 level workstation is required. Purpose: This workbench will be used as a computer desk, having space to accommodate computer accessories, development boards, trainers, and accessories for electronic projects. Preferably Workstation should be assembled at premises. 				
		Ficture attached in the Annex A for reference.				
7.	Workbench Computer	Top Material: Manufactured Wood Base Material: Metal Assembly Required: Yes Requirements (Minimum): Shape Rectangular Base Material Metal Base Wood Powder Coated Construction Metal Details Top Material E1 Grade Lamination sheet Top Construction MDF	No	Local/ Imported	4	

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	Details						
	Edges	Covered with					
		Abs (Doolken-					
		Germany)					
		edging					
	Wood Tone	White & Grey					
	Cabinet Included	No					
	Side Rack	Yes					
	Locking Drawers	Yes					
	No of Drawers	3					
	Pedestal Included	Yes					
	Drawer Glide	Roll Rearing					
	Mechanism	Glides					
	Termite Control Treatment	Yes					
	Dimension in mr Main Desk Side Rack	m (Minimum): 1500 W x 750 D x 760 H 1050 W x 450 D x 710 H					
	Picture attached	in the Annex "A-2" for reference.					
8. Power Supply	 Variable O Variable O (even at max 	output Voltage: 0-32V ±40% (DC output Current: 0-20A ±40% < 32V)) No	European / North American	4		

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	 Input Voltage: 100- 240VAC 50/60 Hz Dual 3-digit LED display USB interface Front panel auxiliary output Overvoltage, over temperature and overload protection 					
	OR Equivalent		· · · ·			
9.	 Digital Microscope: Provide high-definition images and video at 1600X1200 resolution, 1-200X Zoom and 30fps with 2.0MP CMOS sensor, clearly view details. Microscope: Can capture live AVI video or tak images in BMP format while connecting USB electronic microscope to our computer. And it a powerful PCB microscope. Adjustable Light Source: Includes 8 led lights, support dim or brighten light conditions, easy adjust with sliding regulator Durable and Portable usb digital microscope: Finished with aluminum , durable for daily use With simple constructions, easy to install, also lightweight and easy to store for home use. C be connected to device and start the program Compatibility: It should work with Windows 7, and 10, and Mac 	age No e is to an 8	Imported	2		
10.	Powered bread board Technical Specification (Minimum): DC output voltages 0~+15VDC/500mA 0~-15VDC/500mA 0~15VAC/500mA 12,+5VDC/1A Solderless breadboard 2420 tie points	No	Local	4		

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		OP Equivalent					
		OR Equivalent					
11.	Laser Cutter	Technical Specification (Minimum): Laser Technology	No	Imported	1		
		CO2 Laser					
		Working Size					
		1600*1000mm					
		Laser Type					
		Sealed CO2 Glass Laser Tube					
		Laser Power					
		60W/80W/100W/130W/150W/280W/300W					
		Cutting Speed					
		0-40000mm/Min					
		Engraving Speed					
		0-60000mm/Min					
		Cutting Depth					
		Depend					
		Control System					
		DSP Offline / USB					
		Compatible Software					
		Autocad/Coreldraw/Photoshop					
		Voltage					
		220V/50Hz(110V/60Hz)					
		Trademark					
		МС					

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	Transport Package						
	Standard Wooden Box						
	Specification						
	1600*1000mm						
Digital Vibration Meter	Technical Specification (Minimum): Velocity Lo-RMS: 0.1 - 199.9 mm/s	No	European / North	1			
	Velocity Hi-AVE: 0.1 - 199.9 m/s²		American				
	Displacement, peak to peak Hi-PEAK: 0.001 - 1999						
	mm						
	Dimension: 185 mm x 68 mm x 30 mm with						
	integrated or with external probe, incl. workshop test	t					
	certificate						
	compact analyser for predective maintenance of						
	production machinery and for a quick checking of						
	unbalance, misalignment, bearings and gears etc.						
	LCD display with digit height 18 mm						
	accuracy \pm 5% of display value (\pm 2 digits) with						
	integrated accelerometer and with hand strap						
	rugged, polyamid plastic housing, with keypad large						
	LCD display with clear reading, with backlight						
	On-switch, automatic power-Off after approx. 1						
	min., with battery indicator low frequency mode "Lo-						
	RMS" to test low vibrations high frequency mode "Hi	-					
	AVE" to test avarage acceleration displacement pea	ŀ					
	to peak mode "Hi-Peak" large frequency range: 1						
	Digital Vibration Meter	Transport Package Standard Wooden Box Specification 1600*1000mm Digital Vibration Meter Velocity Lo-RMS: 0.1 - 199.9 mm/s Velocity Hi-AVE: 0.1 - 199.9 m/s² Displacement, peak to peak Hi-PEAK: 0.001 - 1999 mm Dimension: 185 mm x 68 mm x 30 mm with integrated or with external probe, incl. workshop test certificate compact analyser for predective maintenance of production machinery and for a quick checking of unbalance, misalignment, bearings and gears etc. LCD display with digit height 18 mm accuracy ± 5% of display value (± 2 digits) with integrated accelerometer and with hand strap rugged, polyamid plastic housing, with keypad large LCD display with clear reading, with backlight On-switch, automatic power-Off after approx. 1 min., with battery indicator low frequency mode "Lo- RMS" to test low vibrations high frequency mode "Hi AVE" to test avarage acceleration displacement peat to peak mode "Hi-Peak"	Transport Package Standard Wooden Box Specification 1600*1000mm Digital Vibration Meter Velocity Lo-RMS: 0.1 - 199.9 mm/s Velocity Hi-AVE: 0.1 - 199.9 ms/s Displacement, peak to peak Hi-PEAK: 0.001 - 1999 mm Dimension: 185 mm x 68 mm x 30 mm with integrated or with external probe, incl. workshop test certificate compact analyser for predective maintenance of production machinery and for a quick checking of unbalance, misalignment, bearings and gears etc. LCD display with digit height 18 mm accuracy ± 5% of display value (± 2 digits) with integrated accelerometer and with hand strap rugged, polyamid plastic housing, with keypad large LCD display with clear reading, with backlight O	Transport Package Standard Wooden Box Specification 1600*1000mm Digital Vibration Meter Velocity Lo-RMS: 0.1 - 199.9 mm/s Velocity Hi-AVE: 0.1 - 199.9 mm/s Velocity Hi-AVE: 0.1 - 199.9 mm/s Displacement, peak to peak Hi-PEAK: 0.001 - 1999 mm Dimension: 185 mm x 68 mm x 30 mm with integrated or with external probe, incl. workshop test certificate compact analyser for predective maintenance of production machinery and for a quick checking of unbalance, misalignment, bearings and gears etc. LCD display with digit height 18 mm accuracy ± 5% of display value (± 2 digits) with integrated accelerometer and with hand strap rugged, polyamid plastic housing, with keypad large LCD display with clear reading, with backlight On-switch, automatic power-Off after approx. 1 min., with battery indicator low frequency mode "Hi AVE" to test avarage acceleration displacement peal to peak mode "Hi-Peak" large frequency range: 10	Transport Package Standard Wooden Box Specification 1600*1000mm Digital Vibration Meter Velocity Lo-RMS: 0.1 - 199.9 mm/s Velocity Hi-AVE: 0.1 - 199.9 m/s² Displacement, peak to peak Hi-PEAK: 0.001 - 1999 mm Dimension: 185 mm x 68 mm x 30 mm with integrated or with external probe, incl. workshop test certificate compact analyser for predective maintenance of production machinery and for a quick checking of unbalance, misalignment, bearings and gears etc. LCD display with digit height 18 mm accuracy ± 5% of display value (± 2 digits) with integrated accelerometer and with hand strap rugged, polyamid plastic housing, with keypad large LCD display with clear reading, with backlight On-switch, automatic power-Off after approx. 1 min., with battery indicator low frequency mode "Hi AVE" to test avarage acceleration displacement peal to peak mode "Hi-Peak"	Transport Package Standard Wooden Box Specification 1600*1000mm Digital Vibration Meter Velocity Lo-RMS: 0.1 - 199.9 mm/s Velocity Hi-AVE: 0.1 - 199.9 m/s² Displacement, peak to peak Hi-PEAK: 0.001 - 1999 mm Dimension: 185 mm x 68 mm x 30 mm with integrated or with external probe, incl. workshop test certificate compact analyser for predective maintenance of production machinery and for a quick checking of unbalance, misalignment, bearings and gears etc. LCD display with digit height 18 mm accuracy ± 5% of display value (± 2 digits) with integrated accelerometer and with hand strap rugged, polyamid plastic housing, with keypad large LCD display with clear reading, with backlight On-switch, automatic power-Off after approx. 1 min., with battery indicator low frequency mode "Hi- AVE" to test avarage acceleration displacement peal to peak mode "Hi-Peak"	Transport Package Standard Wooden Box Specification 1600*1000mm Digital Vibration Meter Velocity Lo-RMS: 0.1 - 199.9 mm/s Velocity Hi-AVE: 0.1 - 199.9 mm/s Displacement, peak to peak Hi-PEAK: 0.001 - 1999 mm Dimension: 185 mm x 68 mm x 30 mm with integrated or with external probe, incl. workshop test certificate compact analyser for predective maintenance of production machinery and for a quick checking of unbalance, misalignment, bearings and gears etc. LCD display with digit height 18 mm accuracy ± 5% of display value (± 2 digits) with integrated accelerometer and with hand strap rugged, polyamid plastic housing, with keypad large LCD display with clear reading, with backlight On-switch, automatic power-Off after approx. 1 min., with battery indicator low frequency mode "Hi AVE" to test avarage acceleration displacement peal to peak mode "Hi-Peak"

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		incl. 2 exchangeable probe tips, for different					
		measuring functions:					
		- short probe tip for standard vibration					
		measurements					
		- long, small probe tip for vibration measurement	:				
		on small or narrow objects, etc.					
		- without probe tip for vibration measurements or					
		smooth object surfaces, etc.					
		operation temperature 0°C ~ +40°C, humidity 30					
		- 90%RH					
		incl. 1x 9 V battery (type 6LR61, artno.: 60					
		9281), with operation manual					
13.	Embedded systems for Al applications Nvidia Jetson Nano or Equivalent	Technical Specification (Minimum):GPU: 128-core MaxwellCPU: Quad-core ARM A57 @ 1.43 GHzMemory: 4 GB 64-bit LPDDR4 25.6 GB/sStorage: microSD (not included)Video Encode: 4K @ 30 4x 1080p @ 30 9x 720p @30 (H.264/H.265)Video Decode: 4K @ 60 2x 4K @ 30 8x 1080p @ 30 18x 720p @ 30 (H.264/H.265)• Camera: 2x MIPI CSI-2 DPHY lanes• ConnectivityGigabit Ethernet, M.2 Key E• DisplayHDMI and display port• USB4x USB 3.0, USB 2.0 Micro-BOthers GPIO, I2C, I2S, SPI, UARTMechanical69 mm x 45 mm, 260-pin edge connector	No	European / North American	10		

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		OR Equivalent					
14.	Embedded systems for advanced Al applications Nvidia Jetson Xavier AGX Dev kit or equivalent	 Technical Specification (Minimum): PCle X16: x8 PCle Gen4/x8 SLVS-EC RJ45: Gigabit Ethernet USB-C: 2x USB 3.1, DP (Optional), PD (Optional) Close-System Debug and Flashing Support on 1 Port Camera Connector: (16x) CSI-2 Lanes M.2 Key M: NVMe M.2 Key E: PCle x1 + USB 2.0 + UART (for Wi-Fi/LTE) / I2S / PCM 40-Pin: Header UART + SPI + CAN + I2C + I2S + DMIC + GPIOs HD Audio Header: High-Definition Audio eSATAp + USB3.0 Type A: SATA Through PCle x1 Bridge (PD + Data for 2.5-inch SATA) + USB 3.0 HDMI Type A: HDMI 2.0 uSD/UFS Card Socket: SD/UFS 	No	European / North American	5		
15.	Embedded systems for professional Al applications NVIDIA Jetson TX2 Developer Kit or equivalent	 Technical Specification (Minimum): Module NVIDIA Pascal™ Architecture GPU 2 Denver 64-bit CPUs + Quad-Core A57 Complex 8 GB L128 bit DDR4 Memory 32 GB eMMC 5.1 Flash Storage Connectivity to 802.11ac Wi-Fi and Bluetooth-Enabled Devices 10/100/1000BASE-T 	No	European / North American	10		

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1			1			1	 v	
		Etherne						
		 USB 2.0 Micro AB (supports recovery and host) 						
		mode)						
		HDMI						
		M 2 Key F						
		• PCI-F vA						
		Gigabit Ethernet						
		 SATA Data and Power 						
		• GPIOs $12C$ $12S$ SPI CAN*						
		TTL LIART with flow control						
		Display Expansion Header*						
		Camera Expansion Header						
		OR Equivalent						
16.	Bio Medical	Technical Specification (Minimum):	No	European	10			
	Certified	• USB 2.0 (1x Host, 1x OTG)		/ North				
	Embedded	• USB 3.0 (2x Host)		American				
	systems for	PCle (1x Mini PCle)						
	respiratory	• I2C (2x)						
	apparatus	• SPI (1x)						
	applications	• UART (3x RS232)						
	Torodox IMv6 with	• PWM (4x)						
	Ivora Carrier Board	● GPIO (up to 40)						
	or Equivalent	 Analog Input (4x) 						
		 Ethernet (1x 10/100/1000 Mbit) 						
		• SATA (1x mSATA)						
		 SDIO/SD/MMC (1x 4 Bit Micro SD) 						
		• CAN (2x)						
		 LVDS (1x Dual Channel) 						
		 S/PDIF In/Out (1x) 						
		• HDMI (1x)						
		• RGB (1x 24 Bit)						
		 Resistive Touch (4/5-wire) 						

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		 Capacitive Touch connector Camera Parallel Interface (1x) Camera Serial Interface (1x) Analog Audio Line in (1x) Analog Audio Mic in (1x) Analog Audio Headphone out (1x) RTC on Board (1x) Along with carrier board OR Equivalent 						
17.	Field Programmable Gate array systems for advanced industrial application with development kits and expansion modules Zynq-700 or Equivalent	 Technical Specification (Minimum): Onboard configuration circuitry 16MB Quad SPI Flash SDIO Card Interface (boot) PC4 and 20 pin JTAG ports HDMI Video OUT 8X LEDs 12V wall adapter or ATX Voltage and Current measurement capability of supplies DDR3 Component Memory 1GB Support 32 data width 16MB Quad SPI Flash IIC - 1 KB EEPROM 200MHz Fixed PL Oscillator (Differential LVDS) 156.25MHz (default) I2C Programmable Oscillator (Differential LVDS) 33.33MHz Fixed PS System Oscillator (Single-Ended CMOS) Gigabit Ethernet GMII, RGMII and SGMII USB OTG 1 (PS) - Host USB IIC Bus Headers/HUB (PS) 1 CAN with Wake on CAN (PS) USB UART (PS) 	No	European / North American	10			

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		 3 User Push Buttons 2 User Switches 8 User LEDs XADC header FMC #1-LPC connector (0 GTX Transceiver, 68 single-ended or 34 differential user defined signals) FMC #2-LPC connector (0 GTX Transceiver, 68 single-ended or 34 differential user defined signals) IIC #2-LPC connector (0 GTX Transceiver, 68 single-ended or 34 differential user defined signals) IIC HUB/Expander Dual Pmod (8 I/O Shared with LED's) Single Pmod (4 I/O Shared with PJTAG) 				
		OR Equivalent				
18.	Field Programmable Gate array systems for industrial application with development kits and expansion modules PYNQ - Z1 or Equivalent	 Technical Specification (Minimum): 650MHz dual-core Cortex-A9 processor DDR3 memory controller with 8 DMA channels and 4 high performance AXI3 slave ports High-bandwidth peripheral controllers: 1G Ethernet, USB 2.0, SDIO Low-bandwidth peripheral controller: SPI, UART, CAN, I2C Programmable from JTAG, Quad-SPI flash, and micro SD card Artix-7 family programmable logic 13,300 logic slices, each with four 6-input LUTs and 8 flip-flops 630 KB of fast block RAM 4 clock management tiles, each with a phase- locked loop (PLL) and mixed-mode clock manager (MMCM) 220 DSP slices On-chip analog-to-digital converter (XADC) 512MB DDR3 with 16-bit bus @ 1050Mbps 16MB Quad-SPI Flash with factory programmed globally unique identifier (48-bit EUI-48/64TM 	No	European / North American	10	

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						 <u> </u>	
	 compatible). MicroSD slot Powered from USB or any 7V-15V source (see recommended products) USB and Ethernet: USB-JTAG Programming circuitry USB-UART bridge USB OTG PHY (supports host only) Gigabit Ethernet PHY Electret microphone with pulse density modulated (PDM) output 3.5mm mono audio output jack, pulse-width modulated (PWM) format HDMI sink port (input) HDMI source port (output) 4 push-buttons 2 slide switches 4 LEDs 2 RGB LEDs Two standard Pmod ports 16 Total FPGA I/O Arduino/chipKIT Shield connector 49 Total FPGA I/O 6 Single-ended 0-3.3V Analog inputs to XADC 4 Differential 0-1.0V Analog inputs to XADC 					<u></u>	
	4 Differential 0-1.0V Analog inputs to XADC OR Equivalent						
19.	Embedded system for Hobby ElectronicsTechnical Specification (Minimum):Broadcom BCM2711, Quad core Cortex-A72 (ARM v8) 64-bit SoC @ 1.5GHzRaspberry Pi 4 or 	No	Imported	20			

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		 Standard 40 pin GPIO header (fully backwards compatible with previous boards) 2 × micro-HDMI ports (up to 4kp60 supported) 2-lane MIPI DSI display port 2-lane MIPI CSI camera port 4-pole stereo audio and composite video port H.265 (4kp60 decode), H264 (1080p60 decode, 1080p30 encode) OpenGL ES 3.0 graphics Micro-SD card slot for loading operating system and data storage 5V DC via USB-C connector (minimum 3A*) 5V DC via GPIO header (minimum 3A*) Power over Ethernet (PoE) enabled (requires separate PoE HAT) Operating temperature: 0 – 50 degrees C ambient 					
20.	Touch Screen For embedded systems application Touch Screen 7 inches Toradex Or equivalent	 Technical Specification (Minimum): Resolution: 800x480px 18-bit RGB 7 inches Touch Interface: I2C 40 pin and 10 pin FFC cable to connect with a Carrier Board Compatible with serial no 17 board (item) 	No	European5 / North American			
21.	Industrial Grade Monitor	 Technical Specification (Minimum): Capacitive, Infrared, Resistive 19 inches HDMII VGA DVI Industrial LCD panel A grade 300nits, Up to 1000nits 	No	Imported 6		 	

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		 AC 110-240V, 50/60Hz Response time 5ms Power consumption ≤35W Metal Shell Aluminum alloy enclosure IP65 seamless front Waterproof, Dustproof Finger, Touch pen, Glove hand OR Equivalent					
22.	Panel PC	 Technical Specification (Minimum): Touch screen parameters Touch screen type: Projected capacitive touch screen 19 inches Theory Clicks: More than 50 million times Operating System Compatibility: Win 7/ Win 8 / Win 10/Win XP / Linux /MAC /Android/CE LED screen parameters Resolution: 1280*1024 Brightness: ≥ 250 cd/m2 Contrast ratio: ≥ 1000:1 Viewing angle: 89/89/89(Typ.) CR≥10) left/right/up/down Power supply parameters Input Power: 110-240V AC 50/60Hz Output power: 12V 5A Overall power consumption: Less than 60W 	No	Imported	3		
		 Standby power consumption: less than 0.5W Version: Android 7.1 CPU: RK3288/RK3399 					

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		 RAM: 2G (4G optional) Memory: Flash 8G(16g/32g optional) Version: Window7 / Window 8 /Window 10 CPU: Intel Celeron J1900; Intel Atom x5-Z8350, Intel core I3/I5/I7 RAM: DDR3 2G/4G/8G/16G (optional) Memory: SSD 32G/64G/128G/256G HDD 500G/1T OR Equivalent 				
23.	MATLAB License	 Academic Use — Individual: The products can be used by a single named user. The products can be activated on up to four different computers, provided that the products are only accessible to and used by that single named user. A named user may not use a product on more than two computers simultaneously. The license must be restricted to a single country of operation. Subscription: Annual 	No	European2 / North American		
24.	QT License	QT for device creation: Targeted OS: Embedded Linux, UWP, Integrity, QNX, VxWork Windows, Linux, Mac, Android, IOS Subscription: Annual	No	European2 / North American		
25.	Solid Works License	SOLIDWORKS Education Edition Software: Comprehensive CAD and engineering development teaching tool features 3D software plus a broad curriculum of exercises and interactive courseware for 3D mechanical CAD, design validation and data management. Subscription Annual	No	European1 / North American		

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26	Tool Kit	Requirements (Minimum)	No	Imported 3	
_0.		408-Piece Mechanics Tool Set with 3-Drawer Heavy	110	importod o	
		Duty Metal Box (Tool Set + Drill Combo Kit)			
		Include Items:			
		Contents: (1) utility knife, (20) utility knife blades			
		screwdriver) magnetic screwdriver Handled			
		screwdriver bits (6) procision screwdriver, manued			
		box kov act (11) SAE box Hov act's 6" Long page			
		nex key set, (11) SAE nex ney set s, 6 Long nose			
		(1) 4 Control ball pairs how more (1) 7 CM (25ft) tons			
		measure, (8) Metric combination wrenches: 8, 10,			
		11, 12, 13, 14, 15, 17mmm, (8) SAE Combination			
		wrenches: 1/4", 5/16", 3/8", //16", 1/2", 9/16", 5/8",			
		3/4", (1) 8" Adjustable wrench, (1) stripper, (55)			
		connector kit, (40) cable ties, (90) hardware kit, (1)			
		1/4" Dr. Ratchet handle, (1) 3/8" Dr. Ratchet handle,			
		(1) 1/2" Dr. Ratchet handle, (10) 1/4" 6 points SAE			
		dr. Sockets: 5/32", 3/16", 7/32", 1/4", 9/32", 5/16",			
		11/32", 3/8", 7/16", 1/2", (10)1/4" 6 points metric dr.			
		Sockets: 4, 5, 6, 7, 8, 9, 10, 11, 12, 13mm, (10) 3/8"			
		6 points SAE dr. Sockets: 1/4", 5/16", 3/8", 7/16",			
		1/2", 9/16", 5/8", 11/16", 3/4", 13/16", (11) 3/8" 6			
		points metric dr. Sockets: 7, 8, 9, 10, 11, 12, 13, 14,			
		15, 17, 19mm, (8) 3/8" 12 points SAE dr. Sockets:			
		5/16", 3/8", 7/16", 1/2", 9/16", 5/8", 11/16", 3/4", (11)			
		3/8" 12 points metric: 7, 8, 9, 10, 11, 12, 13, 14, 15,			
		17, 19mm, (6) 1/2" 6 points SAE dr. Sockets: 1/2",			
		9/16", 5/8", 11/16", 3/4", 7/8", (6) 1/2" 6 points metric			
		dr. Sockets: 14, 15, 17, 18, 19, 21mm (1) 1/2" X 3/8"			
		Adapter, (1) 3/8" X 1/4" Adapter, (1) 1/4"x3"			
		Extension bar, (1) 3/8"X3" Extension bar, (1) 3/8"x6"			
		Extension bar, (1) 1/2"x5" Extension bar, (2) 3/8"			
		Spark sockets: 13/16", 5/8".			
		Cordless Drill Combo Kit, 2-Tool			
		 Ergonomic Design: Lightweight tools designed to 			
		fit the user's needs			
		 Increased Visibility: The DCF885 features a built 			

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		 in Led with 20 second delay after trigger release Includes: (1) DCD771 drill/driver, (1) DCF885 1/4 inches' impact driver, (2) 20V MAX Lithium Ion 1.3 Ah battery packs, 20-volt MAX charger, and (1) kit bag 1 Handed Bit Loading: The DCF885 has a 1/4 inches' hex chuck and accepts 1 inches bit tips, Power Tool Type: Cordless High Performance Motor: The DCD771 delivers 300 Unit Watts Out (UWO) of power ability completing a wide range of applications OR Equivalent 					
27.	Benchtop Multimeter	Type: Benchtop 0.05% basic accuracy True RMS Auto power off Overload and Short circuit protection DC ranges: 0.1 mV to 1000V Resolution:10 μ V to 100 mV AC ranges: 200 mV, 2 V, 20V, 200 V, 750 V Fused and short circuit protected OR Equivalent	No	European / North American	3		
28.	Medical Grade blowers for respiratory apparatus Micronel U65HN- 024KS-6 or equivalent	Technical Specification (Minimum): Electrical MeasuringSupply voltage range [VDC] Unit Minimum = 5Typical 24 Maximum = 26.4Power consumption (free blowing at nominal voltage) Maximum = 110 WPneumatic (Pressure)Air flow (free blowing at nominal voltage) Typical =	No	European / North American	4		

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						J -	
		440[l/min]					
		Minimum air flow at rated speed Minimum 0[l/min]					
		Stat. pressure at rated speed Typical = 100[mbar]					
		Pneumatic (Vacuum)					
		Air flow (free blowing at nominal voltage) Typical =					
		440 [l/min]					
		Minimum air flow at rated speed Minimum = 0 [I/min]					
		Stat. pressure at rated speed Typical = 90 [mbar]					
		Thermal					
		Maximum motor enclosure temperature [°C]					
		Maximum = 70					
		Ambient operating temperature [°C] Minimum = -20					
		Typical = 25 Maximum = 50					
		Ambient storage temperature [°C] Minimum = -20					
		Typical = 25 Maximum = 50					
		Motor					
		Maximum speed for continuous operation Maximum					
		= 57.000 [rpm]					
		Acceleration (at nominal voltage) Typical = 400					
		[rpm/ms]					
		Number of pole pairs Typical 1					
		Terminal resistance Typical = 0.208[Ohm]					
		Terminal inductance Typical = 0.014 [mH]					
		Back EMF-constant Typical = 0.37 [V/Krpm]					
		Torque constant Typical = 3.53[mNm/A]					
1				1			

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		Rotor inertia Typical = 1.2 [g/cm2]					
		Ambient					
		Protection class Typical = IP10					
		Relative humidity Minimum = 10 Maximum = 95					
		[%RH]					
		Oxygen resistence Maximum = 100 [%]					
		Life Time					
		L10 Maximum 20'000[h]					
		Acoustics					
		Acoustic level Maximum = 47 [dB(A)]					
		Mechanical					
		Weight Typical = 240 [gr]					
		Balancing class Typical = G < 2.5 [mm/s]					
		Impeller Inertia Typical = 5.34 [gcm2]					
		OR Equivalent					
29.	Blower Controller	Technical Specification (Minimum):	No	European	4		
	apparatus	Woight :170 g		American			
	Mayon EDOS2						
	24/5, Digital	DC motors up to 120 W					
	positioning						
	Or equivalent						
		vvitnout sensor (DC motors) Yes					
		Digital incremental encoder (2-channel, differential)					

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	Yes			
	Digital incremental encoder (3-channel, differential)			
	Yes			
	Digital Hall sensors (EC Motors) Yes			
	OPERATING MODES			
	Current controller			
	Yes			
	Speed controller (closed loop) Yes			
	Position controller Yes			
	ELECTRICAL DATA			
	Operating voltage V(min.) 11 V			
	Operating voltage V(max.)24 V			
	Logic supply voltage V(min.)optional 11 V			
	Logic supply voltage V(max.)optional 24 V			
	Max. output voltage (factor * V)0.9			
	Max. output current I 10 A			
	Max. time of peak output current I 1 s			
	Continuous output current I 5 A			
	PWM clock frequency of powerstage 50 kHz			
	Sampling rate PI current controller 10 kHz			
	Sampling rate PI speed controller 1 kHz			
	Sampling rate PID positioning controller 1 kHz			
	Max. efficiency 92 %			
	Max. speed (DC) 100000 rpm			
	Max. speed (EC; 1 pole pair)			
		 1		

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				•	J -	
	blockcommutation100000 rpm					
	Max. speed (EC; 1 pole pair) sinusoidal					
	commutation 25000 rpm					
	Built-in motor choke per phase 15 µH					
	INPUTS					
	Hall sensor signals H1, H2, H3					
	Encoder signals A, A, B, B, I, I\					
	Max. encoder input frequency 5 MHz					
	Digital inputs 6					
	Functionality of digital inputs: limit switch, reference					
	switch, general purpose, enable, quickstop,					
	step/direction set value, master encoder, position					
	marker					
	Analog inputs 2					
	Resolution, range, circuit 12-bit, 0+5V					
	Functionality of analog inputs set value, general					
	purpose					
	DIP switch 8					
	Functionality of the DIP switch CAN Node-ID, CAN-					
	Bus Termination					
	OUTPUTS					
	Digital outputs 4					
	Functionality of digital outputs holding brake,					
	general purpose, position compare, ready					
	VOLTAGE OUTPUTS			l		

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	Hall sensor supply voltage +5 VDC, max. 30 mA			
	Encoder supply voltage +5 VDC, max. 100 mA			
	Auxiliary output voltage +VCC , max. 1300 mA			
	INTERFACE RS232 Yes			
	USB 2.0 (full speed) Yes			
	CAN Yes			
	CANopen Slave			
	CANopen application layer DS-301			
	CANopen frameworks DSP-305			
	CANopen profiles motion control DSP-402			
	Gateway function RS232-to-CAN Yes			
	Gateway function USB-to-CAN Yes			
	DISPLAY			
	Status indicator "Ready" green LED			
	Status indicator "Error" red LED			
	PROTECTIVE FUNCTIONS			
	Protective functions: current limit, overcurrent,			
	excess temperature, undervoltage, overvoltage,			
	voltagetransients, short-circuits in the motor cable			
	AMBIENT CONDITIONS			
	Temperature – Operation (min.) -10 °C			
	Temperature – Operation (max.) 55 °C			
	Temperature – Extended Range +55…+83°C,			
	Derating: -0.179 A/°C			
	Temperature – Storage (min.) -40 °C			

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	Temperature – Storage (max.) 85 °C				<u>,</u>
	Humidity (non-condensing) (min.) 5 %				
	Humidity (non-condensing) (max.) 90 %				
	MECHANICAL DATA				
	Weight 170 g				
	Dimension (length) 105 mm				
	Dimension (width) 83 mm				
	Dimension (height) 24 mm				
	Mounting Flange for M3 screws				
	SOFTWARE				
	Installation program EPOS Setup				
	Graphical User Interface EPOS Studio				
	Operating system Windows 10, 8, 7, Windows XP				
	SP3				
	Windows DLL for PC 32-/64-bit				
	PC master IXXAT, Vector, National Instruments,				
	Kvaser, NI-XNET				
	Programming examples MS Visual C#, MS Visual				
	C++, MS Visual Basic, MS Visual Basic.NET,				
	Borland C++,				
	Borland Delphi, NI LabView, NI LabWindows/CVI				
	Linux Shared Object Library X86 32-/64-bit, ARMv7				
	Programming example C++ (Eclipse Project)				
	IEC 61131-3 library for CAN				
	Master				
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Beckhof, Siemens/Helmholz, VIPA				
maxon library for NI SoftMotion National				
Instruments Compact Rio				
FUNCTIONS				
CANopen Profile Position Mode Yes				
CANopen Profile Velocity Mode Yes				
CANopen Homing Mode Yes				
Position Mode Yes				
Interpolated Position Mode (PVT) Yes				
Velocity mode Yes				
Current mode Yes				
Master Encoder Mode Yes				
Step/Direction Mode Yes				
Analog set value Yes				
Path generator with				
sinusoidal/trapezoidal profiles				
Yes				
Position Control Feed Forward Yes				
Velocity Control (Feed Forward) Yes				
Position Marker / Touch Probe Yes				
Quickstop Yes				
Enable Yes				
Position Compare Yes				
Control of holding brakes Yes				
Advanced automatic control settings Yes				

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		OR Equivalent					
30.	Respiratory Module for medical	Technical Specification (Minimum): VENTILATION MODES	No	European / North	2		
	grade respiratory systems	Ventilation mode: PC-CMV PC (Pressure		American			
		Control),VC-CMV VC (Volume Control), PC-SIMV					
	Macawi full respiratory system	SIMV(PC), VC-SIMV SIMV(VC), PC-SIMV+ Bi-Level					
	or equivalent	Ventilation, PC-BIPAP, PC-ACV ACV(PC), VC-ACV					
		ACV(VC), Spn-CPAP CPAP, CFLOW Continuous					
		Flow at pre-set O2 concentration					
	R	REAL-TIME SIGNALS					
		Airway Pressure: Patient Flow, Patient Volume,					
		VENTILATION MODE OPTIONS					
		NIV (Non Invasive Ventilation), PS (Pressure					
		Support) on top of PEEP PSV, PCVR (Pressure					
		Controlled Volume Regulation) PRVC, AutoFlow,					
		AVAPS, Volume Guarantee, HPO & LPO High					
		Pressure Oxygen & Low Pressure Oxygen					
		MEASUREMENTS					
		VT Tidal Volume (in- & exp.) [mand. & spont.], MV					
		Mandatory Volume (in- & exp. & tot.) [mand. &					
		pont.], RR Respiratory Rate [mand. & spont.],					
		Ppeak Peak Pressure (PIP), Pplat Plateau					
		Pressure, PEEP Positive End-Expiratory Pressure,					
		MAP Mean Airway Pressure, FiO2 Fractional					

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------	----	----	----

	Inspired Oxygen, Vleak Leakage volume per breath	
	VENTILATION SETTINGS RANGE	
	VT 2 - 2000 mL , RR 3 - 200 /min, Pinsp, PS Low	
	(Pressure Support) 1 - 90 mbar, Pressure Support 1	
	- 90 mbar , PEEP 0 - 40 mbar, Insp Flow 5000 -	
	100000 mL/min for VC with plateau, Ti, Te	
	and Tramp 150 - 30000 ms (Ti & Te) 60-30000 ms	
	(Tramp) FiO2 21 - 100 Vol.%	
	VENTILATION MANEUVERS	
	Inspiratory Hold Manual start or generation of	
	prolonged inspiration time	
	PERFORMANCE	
	Maximum Pressure 100 mbar at sea level (> 80	
	mbar at 3000m altitude), Maximum Flow > 220	
	L/min	
	ADDITIONAL FUNCTIONALITY	
	Distal and Proximal flow and pressure sensor	
	support	
	OTHER RELATED FUNCTIONALITY	
	Proximal patient flow measurement (including purge	
	system), Proximal airway pressure measurement	
	(including purge system), Triggering functionality in	
	all modes on Flow and or Pressure, Leakage	
	compensation up to > 50 L/min, Nebulizer control	
	output (driver for valve), Compensation of	

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					5	
	compressible volume For Volume controlled modes,					
	Oxygen sensor interface Galv. Analog sensor or					
	paramagnetic digital sensor, System test and					
	calibration functionality, External Safety Valve					
	ADDITIONAL VENTILATION MODES					
	PC-AMV Assisted Manual Ventilation, Neonatal T-					
	piece resuscitation, PC-APRV Pressure controlled -					
	Airway Pressure Release Ventilation, PC-MMV					
	Pressure controlled - Mandatory Minute Ventilation					
	ADDITIONAL VENTILATION MANEUVERS					
	PS High (Pressure Support) PS on top of inspiratory					
	pressure, Recruitment Generate a fixed number of					
	elevated pressure strokes, PPS Proportional					
	Pressure Support, P0.1 measurement figure for					
	weaning purposes, Tube Compensation Automatic					
	Tube Compensation (inspiratory and/or					
	expiratory),Sigh Generate sigh maneuver at set time					
	interval, Expiratory Hold Manual generation of					
	prolonged expiration time					
	ADDITIONAL MEASUREMENTS					
	Flowpeak_insp ,Inspiratory Peak Flow,					
	Flowpeak_exp Expiratory Peak Flow, Pmin_exp					
	Expiratory Minimum Pressure, P0.1 Negative					
	pressure after 100 ms no inspiratory support, RSBI					
	Rapid Shallow Breathing Index, PTP Pressure Time					
				1		

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		Product, Cstat Static Compliance, Rinsp Inspiratory					0	
		Resistance, AutoPEEP Intrinsic PEEP, Tracheal						
		Pressure Derived Tracheal Pressure, Advanced						
		software						
		ENVIRONMENTAL OPERATING CONDITIONS						
		Operating temperature -20 - + 55degrees C,						
		Relative air humidity 5 - 95% R.H., Air Pressure 500						
		- 1100 hPa., Module lifetime expectancy > 30.000						
		hours At moderate Ventilation level, Noise						
		generation < 40 dB At a pressure of 40 cmH2O, ISO						
		3744, Pinsp = 20 mbar, PEEP = 5 mbar, Tslope =						
		200ms, RR = 12 /min at Rp5C20						
		ELECTRICAL OPERATING CONDITIONS						
		Power Supply Voltage 24V DC ±10%, Peak current						
		up to 5A at 24V max. during 200 ms atmaximum						
		insp. pressure setting, Continuous current up to						
		2.5A (during insp.) at 24V at maximum inspiratory						
		pressure setting, Nominal Power consumption 5 -						
		30 VA at 24V depending on Ventilation settings and						
		patient						
		MODULE PROPERTIES						
		Envelope dimensions 120 x 90 x 185 mm (standard)						
		Volume < 2L, Module Weight < 850 gram						
		Also include the evaluation kit						
31.	Full Set Hexacopter Drone	Package Must include (minimum): 1XTarot FY690S Full 6 axle Carbon Aircraft Frame	No	Imported	4			

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		T			-			
	6-axle Aircraft Kit	3K Folding Hexacopter 680mm FPV TL68C01					l	
	750KV Motor GPS	6X750KV Brushless Disk Motor					ľ	
	APM 2.8 Flight	6XHOBBYWING Platinum-30A-Pro 2-6S 30A					ľ	
	Control	Speed Controller FSC					ľ	
		3X12x5 5 3K Carbon Fiber Propeller					ľ	
		1XAPM2 8 APM 2 8 Multiconter Flight Controller 2 5					ľ	
		2.6 Ungraded Built in Compass					ľ	
		2.6 Opgraded Built-In Compass					ľ	
		1X6M GPS with Compass L5883 25cm Cable					ľ	
		5X10cm Servo Extension Lead Wire Cable MALE					ľ	
		TO MALE KK MK MWC flight control Board For RC					ľ	
		Quadcopter					ľ	
		1XDJI GPS Folding Antenna Mount Holder Metal					ľ	
		1X8S-5A 5A U-BEC UBEC Input 9-30V 3-8S Lipo					ľ	
		battery 8-24Nimh R7					ľ	
		18x3.5mm Bullet Connector (banana plug)					ľ	
		1xHook & Loop Fastening Tape					ľ	
		1xT Plug Male Connector Silicone Wire With					ľ	
		11 5CM 14awg					ľ	
		1xIMAX RC B3 Pro Compact Balance Charger					ľ	
		$1 \times 11 \times 11 \times 2200$ MAH 30C 3S1P battery					ľ	
		1X TI. TV 22000AT SUC SSTE Dattery					ľ	
		System					ľ	
00		System	N 1		0			
32.	800°480 FPV	Specification (minimum)	INO	Imported	2		l	
	Goggles Combo						l	
	Kit with 32CH RX	Optics					l	
	SpiroNET ANT	FOV (field of view): 30° diagonal (the same plastic					l	
		optics as DOMV2)					l	
	Fatshark	Interpupillary Distance (IPD): 59 to 69 mm					l	
	Dominator V3 with	(adjustable)					l	
	FSV2442 or	Optional Diopter Lens Inserts: -2, -4, -6 dpt					l	
	equivalent						l	
		Display					l	
		800 x 480 WVGA LCD					l	
		Polarized LED backlight					l	
		NTCS/PAL auto selecting					l	
		Side/Side 3D					I	
		Input HD Port 16:9					l	
		Video 4:3 horizontally stretched						
		Video 4:3 horizontally stretched						

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		·			U	
(Current A/C chip only supports to 720p 50/60 Hz.						
(could be ungraded to 1000 in the future)						
Audio: Stereo						
User Controls						
Channel Selection						
Volume Control						
Wode Selection (Wired/Wireless)						
Display Control						
DVR Control						
HT Control						
Electrical						
Power Supply: 7 - 13 V (2S/3S supply)						
Power Consumption: 300mA wireless/230mA direct	. +					
	<i>,</i> L					
mode (no RX) (@7.4V nominal)						
Driver Board: Using the same as HD's, support						
Side/Side 3D						
PE Modulos: Infinito channel support on multiple						
Kr modules. Infinite channel support on multiple						
bands						
Head Tracker: Modular (sold separately)						
Analog DVR: MicroSD support to 32Gb						
Paged Pate: 6Mbps (MIPC compression 20 fps						
Record Rate. ombps (mjPG compression, 50 lps,						
AVI)						
File playback (native recording, no codec support)						
Lipgradeable via SD card						
DAL (NISC) continuous con outo detect/mede						
PAL/NTSC continuous scan auto detect/mode						
change						
Auto save if power removed						
DVR stay of when not switched on						
Interface						
3.5mm AV in/out port						
Power in port						
2 5mm 2n combono port						
s.onin op earphone port						
MiniDIN4 data port (head tracking)						
MicroSD insert slot						

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						 	 ~	
		RF module port						
		Mechanical: Ergonomic molded beadset w/						
		adjustable headband						
		Features						
		The Dominator V3 FPV goggle features an immersive 16:9 widescreen display for compatibility with HD content and HD digital video links. It supports side/side 3D content in (both analog and HD Port) and is NTSC/PAL auto switching. Integrated DVR records your analog footage and has playback function that may assist in lost model recovery. If the power is disconnected or the battery runs flat,the DVR will auto-save any recorded video,preventing a corrupted card or loss of data. Warning: Exposing the lens to direct sunlight will result in LCD damage.						
		Package Included:						
		1 x FPV Goggle						
		1 x 52 channel Race Band receiver						
		1 x FSV Ballery and its Case						
		1 x 2m AV Coblo						
		1 x Manual						
33.	5G8 5.8GHz Mini	SPECIFICATIONS (minimum):	No	Imported	10			
	FPV Transmitter	Operating Voltage: 2S - 6S			-			
	with antenna	Supply current: 600mA						
		Operating Temperature: watch for normal airflow						
	Team Blacksheep	Audio carrier Frequency: 6.5 MHz						
	TBS Unify Pro	Video Input Impedance: 75 Ohm						
	Or equivalent	Weight: 5g (with SMA, without antenna)						
		Antenna Connector: SMA Female Socket with						
		screw mounting holes. U.FL to VTx						

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		Video Format: NTSC/PAL					
		Output Power: 13dBm (25mW), 23dBm (200mW)					
		Antenna: 5.8G Spironet Antenna					
34.	FPV Receiver for	Specification (minimum):	No	Imported	10		
	UVC OTG	Frequency : 5645MHz~5945MHz					
	Smartphone	Resolution : 640*480 30fps					
	Android Tablet PC	Working Current : USB 5V 190mA					
	Monitor VR	Connector : RP-SMA					
	Headset	Working Temp. : -10~65°C					
		Please calibrate it before use					
	Skydroid 5.8Ghz	Please calibrate it in open area, and keep away					
	150CH True	from transmitter more than 30m. Long press the					
	Diversity or	menu button and power on receiver, enter into					
	Equivalent	calibration mode.					
35.	Mini FPV Camera	Specification (minimum):	No	Imported	10		
	PAL with MIC	Image Sensor:1/3" Super HAD II CCD					
	Support OSD	Horizontal Resolution: 600TVL,4:3					
	RunCam Swift 2	Lens: 2.5mm 130° / 2.3mm 150°/ 2.1mm 165°					
	600TVL or	(Optional)					
	equivalent	Signal System: PAL					
		Integrated OSD: YES					
		Integrated MIC: YES					
		S/N Ration>60dB (AGC OFF)					
		Electronic Shutter Speed: PAL:1/50~100,000;					
		NTSC:1/60~100,000					
		AutoGain Control (AGC): YES					
		Back light compensation (BLC): YES					
		Power DC 5 to 36V					
		Net weight 14g					
		Dimensions 28.5mm * 26mm * 26mm					
36.	PC for AI	Processor	No	Imported	4		
	Applications	Intel® Xeon® Silver 4110 (2.10GHz, 8 cores, 11MB					
		Cache)					
	ThinkStation 920						
	Workstation or	Operating System					
	equivalent	Windows 10 Pro for Workstations 64					
		Memory					

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		8GB DDR4 2666MHz ECC RDIMM							
		Graphics							
		NVIDIA Quadro P620 12GB (Mini DPx4)							
		TTB Hard Drive, 7200RPM, 3.5°, SATA3							
		Optical Drive							
		No 1st Optical Drive Selected							
		Warranty							
		3 Year On-site							
		Network Card							
		2x port Integrated Ethernet							
		Keyboard							
		USB Traditional Keyboard Black English							
		Pointing Device							
		Form Factor							
		Tower 92% Power 1400W							
		M 2 Storage Card							
37.	Heavy Robot	Specification (minimum):	No	Imported	5				
	Chassis	All-Terrain							
		Anodized Aluminum Body							
		Anodized Zinc Tracks, Struts, and Wheels							
	Chassis	2x 12V DC motors with all metal gearboxes							
	Or equivalent	IVIOLOI Specifications:							
		No Lood Current: 1.20							
		Typical Current: 1.3A							
		Stall Current: 11A (Measured using a 28 5000mAb							
1 1			1	1	1	1 1	1		

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		LiPo battery)					
		70mm (2 75") Clearance with Low Center of Gravity					
		Removable Front and Top Panels with Quick Spring					
		Release					
		355 x 175 x 130mm (14" x 6.8" x 5")					
38.	Hexapod Robot Ki	Inclusion (minimum):	No	Imported	4		
	(Hardware Only)	3x 3DoF T-Hex Leg pairs					
	(1x T-Hex body					
	Lvnxmotion T-Hex	6x servo extender cables					
	3DOF or						
	equivalent						
39.	STM32H7	Frequency: 400Mhz	No	Imported	20		
	Development	Package: LQFP100					
	Board	RAM: 1024KB					
		Flash: H750VB: 128KB H743VI: 2048KB (2M)					
		OLED interface – Plug and Play					
		0.96 inch/ 1.3 inch OLED					
		Data storage: W25Q64 (QPSI driver)					
		High speed crystal: 25 MHz					
		Low frequency crystal: 32.768K					
		Power + Programmable LED Lights					
		2 users and reset button					
		All CPU – IO Leads					
		2.54MM integer double spacing pin					
40.	Sensors Kit	Kit Listing:	No	Imported	5		
		White LED Module * 1					
		RGB LED Module *1					
		3W LED Module * 1					
		Traffic Light Module (Black and Eco-friendly) *1					
		Active Buzzer Module *1					
		Passive Buzzer Module *1					
		Digital Push Button Module *1					
		Collision Sensor *1					
		Line Tracking Sensor *1					
		Infrared Obstacle Avoidance Sensor *1					
		Photo Interrupter Module * 1					
		Hall Magnetic Sensor *1					

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_					5	
	Knock Sensor Module *1					
	Digital Tilt Sensor * 1					
	Capacitive Touch Sensor *1					
	Flame Sensor *1					
	Reed Switch Module *1					
	PIR Motion Sensor *1					
	Analog Temperature Sensor *1					
	Analog Rotation Sensor *1					
	Photocell Sensor *1					
	Analog Sound Sensor *1					
	Water Sensor *1					
	Soil Humidity Sensor *1					
	Analog Gas Sensor *1					
	Analog Alcohol Sensor *1					
	Steam Sensor *1					
	Analog Piezoelectric Ceramic Vibration Sensor					
	*1					
	Voltage Sensor *1					
	Thin-film Pressure Sensor (Black and Eco-friendly)					
	*1					
	TEMT6000 Ambient Light Sensor *1					
	GUVA-S12SD 3528 Ultraviolet Sensor *1					
	Digital IR Receiver Module *1					
	Digital IR Transmitter Module *1					
	Pulse Rate Monitor Module *1					
	Joystick Module * 1					
	Rotary Encoder Module *1					
	5V Single Relay Module *1					
	LM35 Linear Temperature Sensor *1					
	DHT11 Temperature and Humidity Sensor *1					
	Magical Light Cup Module *2					
	APDS-9930 Attitude Sensor Module *1					
	ALS Infrared LED Optical Proximity Detection					
	Module *1					
	MMA8452Q Module Triaxial Digital Acceleration Tilt					
	Sensor * 1					
	keyestudio 9G Servo Motor *1					
	HC-SR04 Blue Ultrasonic Sensor *1					

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		Keyestudio 0802 LCD module 5V blue screen (with					
		backlight) *1					
		kevestudio I2C 8x8 LED Dot Matrix *1					
41.	Google Cloud IoT	On-board FTDI2232 IC for 4-wire JTAG debugging	No	Imported	4		
	Development Kit	Various commercial and free IDE options for JTAG					
	for creating	debugging and software development					
	Internet of Things	Arduino connector to extend kit and add shields					
	(IoT)	Open schematics and layout files					
	()	Eclipse based IDE for single-step JTAG debugging					
	T4-G-Q-4020 or	UART-AT commands to connect T4-G-Q-4020 to					
	oquivalone	Fight sensors and actuators on-board					
		Ambient light luminosity					
		3D accelerometer					
		3D gyroscope/rotation					
		3D magnetic field					
		Temperature					
		Humidity					
		Pressure					
		PIR sensor					
		Out-of-box drivers for sensors in demo applications					
		Miscellaneous headers, test-points for power					
		measurement, direct connect to battery, boot-					
		configuration, and other measurements					
42.	ARM-based loT Kit	t Electronic components (Minimum):	No	Imported	4		
	for Cloud IoT Core	1x Photo Cell					
		2x Breadboard Trim Potentiometer					
		5x 10K 5% 1/4W Resistor					
		5x 560 ohm 5% 1/4W Resistor					
		2x Diffused 10mm Blue LED					
		1x Electrolytic Capacitor - 1.0uF					
		1x Ceramic Capacitor - 0.1uF					
		2x Diffused 10mm Red LED					
		2x Diffused 10mm Green LED					
		3x 12mm Tactile Switches					
43.	Injection Molding	Technical Specification (minimum):	No	Imported	1		
	Machine						

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Power	0.5kw			
Shot weight	20grams			
Nozzle hole	2mm			
Diameter				
Motor Accuracy	0 002mm			
	Water			
Power source				
	200*145mm*14			
Max Mold cizo	200 14311111 14 5mm			
Iviax Iviolu Size				
	DC30V			
Power				
	PC,PS,PP,ABS			
Material	,1PU			
	900mm*210mm			
Machine Size	*350mm			
Machine weight	120kgs			
High accuracy (can micro product) (Lea 1): PID temperature 2): Mold clamping a 3): Shot weight acc 4): Shot peak press	a make small parts ading technology) ∋ control±1°C accuracy 0.001mr suracy 0.001g sure 1kg	s weight<0.01g m		
High efficiency: 3.5 Traditional hydrauli Shot speed: 160~2 Molding cycle :7~1	s shaping cycle c press: 00mm/s 0 /s			

Special Instructions

Instl/Assy/Comm issioning Req	Yes ✓	No	Contract with OEM/Supplier	Yes ✓ (against ser no 1-5, 8,11- 22,27-43)	No
Performance Bond Req	Yes ✓ (against ser no 1-5, 8,11-22,27- 43)	No	Offer Req for Package Deal	Yes	No√
Note: (If any)			01-year Warranty req and Duration	Yes ✓	No
Maint Spare Req	Yes	No√	Essentially Running spare req	Yes	No ✓
Pub/Lit Req	Yes ✓	No	Req of Cert for test data results	Yes ✓ (against ser no 1-5, 8,11- 22,27-43)	No
Training Required	Local ✓	Foreign	Req of Calibration	Yes	No✓

Description		Bido	der	Tech Scrutiny to be done by User			
	Yes	No	Alternate Offer	Accepted	Rejected	Reasons of Rejection	
Environment Conditions							
(a) Temperature range: 05°C to +60°C							
(b) Relative humidity: 0-70% non-condensing							
Warranty period Two years from the date of commissioning.							
A warranty sticker is to be pasted on each imported item by the							
Supplier / OEM highlighting Name of Firm, Contract No and							
date, Description of Store and Warranty validity							
Training Notes Supplier will provide a set of handouts for							
training on operation and maintenance of the equipment							
Publications Supplier is to provide hard and soft copies							
(CD) of following manuals.							
(a) Operational / Maintenance manual : - Qty 01 with							
Equipment and additional Qty 02 for record purposes							
and should consist of following sections: -							
(1) Equipment Description /Operation: -							
(a) Specifications							

				J -
	(b) Description			
	(c) Operation			
	(2) Servicing: -			
	(a) Maintenance Schedule			
	(b) Adjustment / test			
	(c) Removal / Installation procedure			
	(d) Tools Used			
	(3) Trouble shooting guide			
	(4) Cleaning requirements			
	(5) Shipping and receiving			
	(6) Storage requirements			
(b)	IPB (Illustrated Parts Breakdown Manual) should have full			
	parts description along with detailed diagrams (exploded			
(C)	Experimental manuals which must contain the list and			
	procedure of the experiments that equipment can			
(-1)	perform.			
(a)	functions (experiments			
<u>Cro</u>	runctions / experiments.			
5pa	res / rechnical Support			
(a)	and onsure spares and technical support / assistance for			
	novt 10 voors			
(h)	Comprehensive list of spares required for scheduled			
(0)	maintenance of Equipment is to be provided			
(0)	Any software provided must have its license			
(d)	Software upgrade support must be provided free of cost			
(4)	for 10 x years with renewed license at every upgrade			
(e)	Supplier must also provide calibration service for at least			
(0)	5 x vears after commissioning			
Add	itional Spare / Replaceable parts.			
(a)	Replaceable spare / parts during scheduled inspections			
	are to be identified and provided as per requirement along			
	with equipment sufficient to cater five years consumption.			
(b)	All specialized / standard tools required for inspection /			
	repair / servicing must be supplied along with equipment.			
Phy	sical Inspection Criteria: 100% physical inspection of			
store	e will be carried out before commissioning of the equipment			

for for	ollowing details:-			
(a)	For physical damage, scratches and deformity.			
(b)	Accessories /components as per contractual			
. ,	specifications.			
(c)	Technical Manuals (Operation manual, user guide, IPBs).			
(d)	Quality certificate and calibration certificate by the OEM.			
(e)	OEM certificate and verifiable documents by the supplier			
	that store has been procured from certified source and is			
	factory new and from latest production.			
(f)	Brand name and country of origin.			
Con	nmissioning			
(a)	Commissioning of the equipment will be carried out by			
	OEM rep at his own cost and risk at designated place at			
	NUTECH.			
(b)	Any special requirement for installation, operation and			
	commissioning must be specified in the offer by the			
	supplier.			
Trai	ning: 01 week OEM operational/ maintenance training at			
NUT	ECH			
Imp	rovement and Safety Measures: Any improvement and			
safe	ty measures suggested by NUTECH during commissioning			
are	to be resolved by the supplier / manufacturer at no extra			
cost				
Liab	ility of Supplier			
(a)	OEM certificate of authorized dealership Supplier is to			
	provide original OEM certificate of subject equipment			
	bought directly from the manufacturer and being an			
	authorized dealer.			
(b)	In case the equipment supplied is not compatible with			
	specifications, the supplier will be obliged to call his			
	representatives at his own cost for consultation and			
•	corrective action.			
Spe	CIAI NOTES			
(a) A	Additional requirements for the maintenance of equipment			
(h) (ii any) must be intimated by the supplier in technical offer.			
(n) s	Supplier must provide the list of organizations using same			
(c) [Equipment must be a standard product of OEM system at			
e (c) E	equipment in Pakistan (if any). Equipment must be a standard product of OEM available at			

			Page 54	of 98
web address of OEM.				
(d) In case of premature failure of the equipment, OEM must				
replace / rectify the item free of cost. Required				
transportation charges would be borne by the supplier.				

Firm Name:
Signature:
Name:
Designation:



Workstation (3 Level Adjustable)

Workbench Computer

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Annex-B

TECHNICAL OFFER NUTECH / SCM /Innovation Lab 2021 / TD-211

Fill in following essential parameters:-

- 1. Validity of Offer: _____Days (Should not be less than **90 days**)
- 2. Delivery period: _____Days (After placement of order)
- 3. Country of Origin:
- 4. Warranty Period:

<u>General</u>

- 1. GST Number: _____(Enclose Copy)
- 2. NTN / CNIC: _____(if exempted, provide valid exemption certificate)

Payment Terms (In continuation of IT Document clause 12)

In FOR Cases 50% advance payment against BG/CDR/Pay Order/DD/BC through cross cheque or inland LC 50% payment after delivery, installation / commissioning /user satisfaction certificate through cross cheque or inland LC Or 100% payment may be considered on delivery of the store through cross cheque or inland LC Details of Foreign Principal Information with account details)

- 1. Name / Title:
- 2. Address:

OEM Name:	Firm Name:	Signature:
OEM Focal Person:	Firm Focal Person:	Official Seal:
OEM Phone Number:	Firm Phone Number:	Name & CNIC:
OEM Email Id:	Firm Email Id:	Designation:

<u>Annex C</u>

FINANCIAL OFFER

NUTECH / SCM /Innovation Lab/TD-216

Ser	Part No	Item Name/Size			Sp	ecification	A/U	Qty Req	Unit Price PKR (Including Tax)	Total Price PKR (Including Tax)
1.		3D Scanner	 Time no Time no Plug-ar Uses a require Technical 	eeded for a eeded for a nd-play. Ea safe struct protection specificat	i single sca i 360° scan sy set-up w ured white glasses ions (Mini i	n: 4 seconds in Auto Scan mode: 1 minute vith automated calibration light, no laser or other light sources that mum):	No	1		
			Scan Mode Scan Speed	Auto scan 1 min.	Fixed scan 4 s					
			Mode of Alignment Single Shot	Feature; Manual ≤ 0.05 mm	Turntable ; Manual ≤ 0.05 mm					
			Maximum Scan Volume / Minimum Scan Volume	200 x 200 x 200 mm / 30 x 30 x 30 mm	1200 x 1200 x 1200 mm / 30 x 30 x 30 mm					
			Range of Single Capture Point	200 x 150 mm	200 x 150 mm					
			Distance	mm ~ 0.2 mm	mm ~ 0.2 mm					
			Texture File Format	Yes OBJ, STL,	Yes OBJ, STL,					

2. 3D Printer (SLA) 3D Printer 3D Printer (SLA) 3D Printer and made in 1-1 (Jght White Source Light Light (Jght White Source Light Light) (Jght White Source Light) (Jgh				ASC.	ASC.				
2. 3D Printer 3D Printer No 1 3D Printer 3D Printer Source and the different type of resin such as castable resin, tough resin biold be compatible with 3rd party 3D printing resins No 1 2. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins is the available resin biocompatible resin No 1 3D printer should be compatible with 3rd party 3D printing resins is the available resin biocompatible resin No 1 3D printer should be campatible with 3rd party 3D printing resins is the available available available available No 1 Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printer 2050 µm (0.025) Processing) Printing Size 120 × 67.5 × 150 mm (V.2 B xH) Processing) Printing Size 120 × 67.5 × 150 mm (V.2 B xH)				PLY	PLY				
Image: Second State Sta			Camera	1.3	1.3				
Image: space of the integrity of the integrity and better printing space of the integrity and the stability of the projection signal. No 1 Image: space of the integrity into integrity is the integrity of the integrity			Resolutio	Megapixe	Megapixe				
Image: Source Light Upthie White Survey Light Stand-off 290 ~ 290 ~ 290 ~ 290 ~ 290 ~ 290 ~ 290 ~ 290 ~ 280			n						
Source Light Light Light Stand-off 290 290 Distance 480 mm 42 kg / Weight u 42 kg / 42 kg / npacked / 7.0 kg 7.0 kg Dimensio 570 x 210 570 x 210 Dimensio 570 x 210 mm 70 kg Power 50 W 50 W Supply Dimensio 570 x 210 Input DC: 12 V DC: 12 V Voltage 7.3 33 A /3.33 A 2. 3D Printer should be compatible with 3rd party 3D printing resins No 1 (SLA) flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the interfity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DL2 v 67.5 x 150 mm (x 8 xH) Processing Printing Size 120 v 67.5 x 150 mm (x 8 xH) A xis layer 22.56			Light	White	White				
20 200 ~			Source	Light	Light				
2. 3D Printer 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins input body and be compatible with 3rd party 3D printing resins No 1 2. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins input body and be compatible with 3rd party 3D printing resins No 1 (SLA) SLA Differentiation of the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality No 1 Toruch screen should be available Advanta and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Size 3D Printing Size 120 × 67.5 × 150 mm (L × B × H) Z axis layer 120 × 67.5 × 150 mm (L × B × H) Z axis layer			Stand-off	290 ~	290 ~				
Weight u 4.2 kg / 7.0 kg 7.0 kg packed 7.0 kg 7.0 kg Dimensio 570 x 210 7.0 kg n x 210 mm x210 mm Power 50 W 50 W Supply Input DC: 12 V Input DC: 12 V DC: 12 V Voltage / 3.33 A / 3.33 A 2. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 30 Printing Size 10 × 67.5 × 150 mm (0.025 mm (0.025 height / 0.058 mm) X-Y axis Printing Size 120 × 67.5 × 150 mm (0.025 height / 0.058 mm) X-Y axis 62.5 µm (0.0625 height / 0.058 mm) X-Y axis			Distance	480 mm	480 mm				
Image in the set of the image is a			Weight u	4.2 kg /	4.2 kg /				
2. 3D Printer SLAP 3D Printer should be compatible with 3rd party 3D printing resins flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Technology DLP (Digital Technology 3D Printing Fixibility to try the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Technology DLP (Digital Technology 3D Printing Fixibility and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Technology DLP (Digital Technology 3D Printing Fixibility and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Size 120 × 67.5 × 150 mm (L × B ×H) Z axis layer Z axis layer 25/50 µm (0.025 height 70.05 mm) X-Y axis			npacked /	7.0 kg	7.0 kg				
Dimensio 570 x 210 570 x 210 mm x 210 mm No 1 No 1 Power 50 W 50 W 50 W Supply 1/3.33 A /3.33 A 1 Input DC: 12 V Voltage /3.33 A SD Printer SD Printer should be compatible with 3rd party 3D printing resins No 1 flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing 3D Printing Light Processing) Printing Size Printing Size 120 × 67.5 × 150 mm (0.025 height Axis layer 25/50 µm (0.025 height Axis layer 25.55 µm (0.025 height Presolution Mm (0.25 height Proxessing Print			packed						
n x 210 mm x 210 mm Power 50 W 50 W Supply Input DC: 12 V Input DC: 12 V DC: 12 V Voltage /3.33 A /3.33 A Z. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins No 1 (SLA) flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Light Processing) Printing Size 120 × 67.5 × 150 mm (L × B × H) Z axis layer 26.5 µm (0.025 resolution K-Y axis 62.5 µm (0.0625 resolution resolution mm)			Dimensio	570 x 210	570 x 210				
Power 50 W 50 W Supply DC: 12 V DC: 12 V Input JD: 12 V /3.33 A 2. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins No 1 (SLA) flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality No 1 Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital rechnology Printing Size 120 × 67.5 × 150 mm(L x B xH) Z axis layer Z axis layer 26/50 µm (0.025 height /0.05 mm) X-Y axis 62.5 µm (0.025 height /0.05 mm) X-Y axis 62.5 µm (0.025 resolution mm(L x B xH)			n	x 210 mm	x 210 mm				
Supply DC: 12 V DC: 12 V Voltage /3.33 A /3.33 A 2. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin No 1 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality No 1 Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Technology DLP (Digital Light Priocessing) Printing Size 120 × 67.5 x 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height Z axis layer 25/50 µm (0.025 resolution 25.5 µm (0.0652 resolution			Power	50 W	50 W				
Input DC: 12 V Voltage			Supply						
2. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins No 1 2. 3D Printer 3D Printer should use the self-developed Full HD 1080p resolution light resin, biocompatible resin No 1 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality No 1 Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis K - Y axis 62.5 µm (0.0625 resolution mm) Expended			Input	DC: 12 V	DC: 12 V				
2. 3D Printer 3D Printer should be compatible with 3rd party 3D printing resins No 1 flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Size 120 × 67.5 × 150 mm (L × B ×H) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			Voltage	/ 3.33 A	/ 3.33 A				
(SLA) flexibility to try the different type of resin such as castable resin, tough resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Light Processing) Printing Size 120 × 67.5 × 150 mt (L × 8 ×t) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)	2.	3D Printer	3D Printer	should be	compatible	with 3rd party 3D printing resins	No	1	
(SLA) resin, biocompatible resin 3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			flexibility to	o try the diff	erent type	of resin such as castable resin, tough			
3D printer should use the self-developed Full HD 1080p resolution light engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L × B × H) Z axis layer Z5/50 µm (0.0625 resolution mm) X-Y axis 62.5 µm (0.0625 resolution mm)		(SLA)	resin, bioc	ompatible r	esin				
engine, which can ensure more stable LED intensity and better printing quality Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			3D printer	should use	the self-de	veloped Full HD 1080p resolution light			
available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing Technology Light Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.0025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution			engine wh	hich can en	sure more s	stable LED intensity and better printing			
Touch screen should be available Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L × B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			quality						
Advanced architecture main board and self-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			Touch sere	on should	ha availahl	9			
Advanced architecture main board and sen-developed proprietary light engine work together perfectly. Dual-core 800 MHz ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			Advanced	orobitootur	be availabl	c rd and aalf davidanad propriatory light			
engine work together perfectly. Dual-core 800 MH2 ARM processor ensures high-performance and better user experience. The mainboard is designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Light Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			Auvanceu		e main boa				
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designed and made in a 10-layer high precision board, safeguarding EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			ensures hi	gh-perform	ance and b	etter user experience. The mainboard is			
EMC, the integrity and the stability of the projection signal. TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			designed a	and made ir	ו a 10-laye	^r high precision board, safeguarding			
TECHNICAL SPECIFICATIONS (Minimum): 3D Printing DLP (Digital Technology Light Processing) Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer Z axis layer 25/50 µm (0.025 height / 0.05 mm) X-Y axis 62.5 µm (0.0625 resolution mm)			EMC, the i	ntegrity and	d the stabili	ty of the projection signal.			
3D Printing TechnologyDLP (Digital Light Processing)Printing Size120 × 67.5 × 150 mm (L x B xH)Z axis layer height25/50 μm (0.025 ho.05 mm)X-Y axis resolution62.5 μm (0.0625 mm)			TECHNIC	AL SPECIF	ICATIONS	(Minimum):			
TechnologyLight Processing)Printing Size120 × 67.5 × 150 mm (L x B xH)Z axis layer25/50 µm (0.025 heightK-Y axis62.5 µm (0.0625 resolutionresolutionmm)			3D Printing	a DL	P (Digital				
Processing) Printing Size 120 × 67.5 × 150 mm (L x B xH) Z axis layer 25/50 μm (0.025 height X-Y axis 62.5 μm (0.0625 resolution			Technolog	v Liq	ht				
Printing Size $120 \times 67.5 \times 150$ mm (L x B xH) Z axis layer $25/50 \ \mu m (0.025)$ height X-Y axis $62.5 \ \mu m (0.0625)$ resolution				Pro	ocessina)				
mm (L x B xH) Z axis layer 25/50 μm (0.025 height / 0.05 mm) X-Y axis 62.5 μm (0.0625 resolution mm)			Printing Si	ze 12	0 × 67.5 × 1	50			
Z axis layer 25/50 μm (0.025 height / 0.05 mm) X-Y axis 62.5 μm (0.0625 resolution mm)				mr	n (L x B xH)				
height / 0.05 mm) X-Y axis 62.5 μm (0.0625 resolution			Z axis lave	er 25.	/50 µm (0.02	25			
X-Y axis 62.5 μm (0.0625 resolution mm)			height	/ 0	.05 mm)				
resolution mm)			X-Y axis	62	5 um (0.062	25			
			resolution	mr	n)				
Light source 405 nm LED			Light source	ce 40	5 nm I FD [.]				
			Z axis laye height X-Y axis	mr 25. / 0 62 mr	n (L x B xH) /50 µm (0.02 .05 mm) .5 µm (0.062 n)	25			

	50,000 hours life
	span
3D Printing	FlashPrint
Software	
3D File format	STL
Connectivity	USB Cable, USB
	Stick, Wi-Fi
Printer	360 x 310 x 565
dimensions	mm
Printer weight	17.8 kg
Power	100-240v, 50-
	60Hz, 1A
3D PRINTING SF	PECIFICATIONS (
Build volume (in	1.215
liters)	
Build volume (in	120 × 67.5 × 150
millimeters)	mm
Layer resolution	Z: 25 / 50
,	microns (0.025 /
	0.05 mm) X-Y:
	62.5 microns
	(0.0625 mm)
Print technology	Digital Light
I mill toomlology	Processing (405
	nm I FD with
	50 000 hours life
	snan)
	spanj
CONNECTIVITY	
	Voc
	Tes Vee
VVI-FI	res
	/
SIZE & WEIGHT	(Minimum):
Product	360 x 310 x 565
dimensions	mm
Product weight	17.8 kg
SOFTWARE	
File formats	STL
. lio formato	

		Included FlashPrint software			
3.	Digital Oscilloscope	 Technical Specification (Minimum): 10M sample standard and 20M sample interleaved 30000 to 50000 waveforms/s update rate 100MHz dual channel Sensitivity down to 1mV/div(2mV/div) low noise Math functions such as +, -, *, /, FFT 	No	2	
4.	Function Generator	Technical Specification (Minimum): Frequency range: 0.5 Hz5 MHz (sine); arbitrary 0.5 Hz5 MHz (or higher) Waveforms: Sine, square/pulse, ramp, white noise, arbitrary (exp. rise/fall, sin(x)/x, staircase etc.; 45 built-in signal and user definable arbitrary waveforms) OR Equivalent	No	2	
5.	Handheld Multi Meter	 Technical Specification (Minimum): 0.05% basic accuracy True RMS Auto power off Overload protection DC ranges: 0.1 mV to 1000 V Resolution:10 μV to 100 mV AC ranges: 200 mV- 2 V, 20 V- 750 V (or higher) Fuse for short circuit protection 	No	4	
6.	Workstation (3 Level	 Work Station (Size6'x2'x6') Wooden with metallic base (pipe size 1.5 inches) Power Sockets and additional accessories are not required. 	No	4	

	Adjustable)	Just 3 lev Purpose: This workbench w accommodate col and accessories f be assembled at Picture attached i	vel workstation is r vill be used as a co mputer accessorie for electronic proje premises. n the Annex "A-2"	equired. omputer desk, having space to s, development boards, trainers, cts. Preferably Workstation should for reference.			
7.	Workbench	 Top Material: I 	Manufactured Woo	d	No	4	
	Computer	 Base Material: 	Metal				
	Compator	 Assembly Req 	uired: Yes				
		Requirements (M	linimum):				
		Shape	Rectangular				
		Base Material	Metal				
		Base Wood	Powder Coated				
		Construction Details	Metal				
		Top Material	E1 Grade Lamination sheet				
		Top Construction Details	MDF				
		Edges	Covered with				
			Abs (Doolken-				
			edging				
		Wood Tone	White & Grey				
		Cabinet Included	No				
		Side Rack	Yes				
		Locking Drawers	Yes				
		No of Drawers	3				
		Pedestal Included	Yes				

							1
		Drawer Glide Mechanism Termite Control Treatment	Ball Bearing Glides Yes				
		Dimension in m	m (Minimum):	-			
		Main Desk Side Rack	1500 W x 750 D x 760 H 1050 W x 450 D x 710 H				
		Picture attached	in the Annex "A" fo	or reference.			
8.	Power Supply	 Variable O Variable O Input Volta Dual 3-dig USB interf Front pane Overvoltag 	Putput Voltage: 0 Putput Current: 0 age: 100- 240VAC it LED display ace el auxiliary o ge, over tempera	-32V ±40% (DC) -20A ±40% (even at max 32V) 50/60 Hz utput ture and overload protection	No	4	
9.	USB Digital Microscope Endoscope Magnifying Glass Camera Zoom for PCB Inspection Phone Repair	 OR Equivalent Digital Microsover 1600X1200 researces of the sensor, clearly Microscope: Construction of the sensor of the sensecn of the sensor of the sensor of the sensor of the sensor o	cope: Provide high solution,1-200X Z y view details. Can capture live A connecting USB ele verful PCB microso pht Source: Include s, easy to adjust w Portable usb digital	-definition image and video at oom and 30fps with 2.0MP CMOS /I video or take images in BMP ectronic microscope to our computer. cope. es 8 led lights, support dim or brighten <i>r</i> ith sliding regulator microscope: Finished with aluminum	No	2	

		 , durable for daily use. With simple constructions, easy to install, also lightweight and easy to store for home use. Can be connected to device and start the program. Compatibility: It should work with Windows 7, 8 and 10, and Mac OR Equivalent 			
10.	Powered bread board	Technical Specification (Minimum): DC output voltages • 0~+15VDC/500mA • 0~-15VDC/500mA • 0~15VAC/500mA • 12,+5VDC/1A Solderless breadboard • 2420 tie points OR Equivalent	No	4	
11.	Laser Cutter	Technical Specification (Minimum): Laser Technology CO2 Laser Working Size 1600*1000mm Laser Type Sealed CO2 Glass Laser Tube Laser Power 60W/80W/100W/130W/150W/280W/300W Cutting Speed 0-40000mm/Min Engraving Speed 0-60000mm/Min	No	1	

			Cutting Depth			
		I	Depend			
			Control System			
		I	DSP Offline / USB			
			Compatible Software			
			Autocad/Coreldraw/Photoshop			
			Voltage			
			220V/50Hz(110V/60Hz)			
		-	Trademark			
		I	MC			
		-	Transport Package			
		ę	Standard Wooden Box			
		ę	Specification			
			1600*1000mm			
12.	Dig Met	gital Vibration eter	Technical Specification (Minimum): Velocity Lo-RMS: 0.1 - 199.9 mm/s	No	1	
			Velocity Hi-AVE: 0.1 - 199.9 m/s²			
			Displacement, peak to peak Hi-PEAK: 0.001 - 1999 mm			
			Dimension: 185 mm x 68 mm x 30 mm with integrated or with external			
		ł	probe, incl. workshop test certificate			
			compact analyser for predective maintenance of production machinery			
		ć	and for a quick checking of unbalance, misalignment, bearings and gears			
		e	etc.			
			LCD display with digit height 18 mm			
			accuracy \pm 5% of display value (\pm 2 digits) with integrated			
		ė	accelerometer and with hand strap rugged, polyamid plastic housing, with			

		keypad large LCD display with clear reading, with backlight			
		On-switch, automatic power-Off after approx. 1 min., with battery			
		indicator low frequency mode "Lo-RMS" to test low vibrations high			
		frequency mode "Hi-AVE" to test avarage acceleration displacement peak			
		to peak mode "Hi-Peak" large frequency range: 10 Hz up to 1 kHz			
		(Lo), 1 kHz up to 15 kHz (Hi)			
		incl. 2 exchangeable probe tips, for different measuring functions:			
		- short probe tip for standard vibration measurements			
		- long, small probe tip for vibration measurements on small or narrow			
		objects, etc.			
		- without probe tip for vibration measurements on smooth object			
		surfaces, etc.			
		operation temperature 0° C ~ +40°C, humidity 30 - 90%RH			
		incl. 1x 9 V battery (type 6LR61, artno.: 60 9281), with operation			
		manual			
13.	Embedded systems for Al applications Nvidia Jetson Nano or Equivalent	 Technical Specification (Minimum): GPU: 128-core Maxwell CPU: Quad-core ARM A57 @ 1.43 GHz Memory: 4 GB 64-bit LPDDR4 25.6 GB/s Storage: microSD (not included) Video Encode: 4K @ 30 4x 1080p @ 30 9x 720p @ 30 (H.264/H.265) Video Decode: 4K @ 60 2x 4K @ 30 8x 1080p @ 30 18x 720p @ 30 (H.264/H.265) Camera: 2x MIPI CSI-2 DPHY lanes Connectivity Gigabit Ethernet, M.2 Key E Display HDMI and display port 	No	10	
		• USB 4x USB 3.0, USB 2.0 Micro-B			

		Others GPIO, I2C, I2S, SPI, UART Mechanical 69 mm x 45 mm, 260-pin edge connector OR Equivalent			
14.	Embedded systems for advanced Al applications Nvidia Jetson Xavier AGX Dev kit or equivalent	 Technical Specification (Minimum): PCle X16: x8 PCle Gen4/x8 SLVS-EC RJ45: Gigabit Ethernet USB-C: 2x USB 3.1, DP (Optional), PD (Optional) Close-System Debug and Flashing Support on 1 Port Camera Connector: (16x) CSI-2 Lanes M.2 Key M: NVMe M.2 Key E: PCle x1 + USB 2.0 + UART (for Wi-Fi/LTE) / I2S / PCM 40-Pin: Header UART + SPI + CAN + I2C + I2S + DMIC + GPIOS HD Audio Header: High-Definition Audio eSATAp + USB3.0 Type A: SATA Through PCle x1 Bridge (PD + Data for 2.5-inch SATA) + USB 3.0 HDMI Type A: HDMI 2.0 uSD/UFS Card Socket: SD/UFS 	No	5	
15.	Embedded systems for professional Al applications NVIDIA Jetson TX2 Developer Kit or equivalent	 Technical Specification (Minimum): Module NVIDIA Pascal™ Architecture GPU 2 Denver 64-bit CPUs + Quad-Core A57 Complex 8 GB L128 bit DDR4 Memory 32 GB eMMC 5.1 Flash Storage Connectivity to 802.11ac Wi-Fi and Bluetooth-Enabled Devices 10/100/1000BASE-T Etherne USB 3.0 Type A 	No	10	

		 USB 2.0 Micro AB (supports recovery and host mode) HDMI M.2 Key E PCI-E x4 Gigabit Ethernet Full-Size SD SATA Data and Power 			
		• GPIOs, I2C, I2S, SPI, CAN*			
		• TTL UART with flow control			
		Display Expansion Header*			
		Camera Expansion Header			
		OR Equivalent			
16.	Bio Medical	Technical Specification (Minimum):	No	10	
	Certified	• USB 2.0 (1x Host, 1x OTG)			
	Embedded	• USB 3.0 (2x Host)			
	systems for	PCIe (1x Mini PCIe)			
	respiratory	• I2C (2x)			
	apparatus	• SPI (1x)			
	applications	• UART (3x RS232)			
	Toradex IMx6	• PWM (4x)			
	with Ixora	• GPIO (up to 40)			
	Carrier Board	Analog Input (4x)			
	or Equivalent	• Ethernet (1x 10/100/1000 Mbit)			
		• SATA $(1 \times mSATA)$			
		• SDIO/SD/MMC (1x 4 Bit Micro SD)			
		• CAN (2X)			
		• LVDS (1x Duai Channel)			
		• S/PDIF In/Out (1x)			
		RGB (IX 24 BIL) Desistive Teuch (4/5 wire)			
		Capacitive Fouch connector Camera Parallel Interface (1x)			
		Camera Paraller Interface (1x) Camera Social Interface (1x)			
		• Camera Senar Intenace (IX)			

		Analog Audio Mic in (1x)			
		 Analog Audio Headphone out (1x) 			
		• RTC on Board (1x)			
		Along with carrier board			
		OR Equivalent			
17	Field	Technical Specification (Minimum):	No	10	
17.	Programmable	- Ophoard configuration circuitry	INO	10	
	Gate array	Onboard configuration circuitry 16MB Qued SDI Floop			
	Systems for	IOIVIB Quad SPI Flash ODIO Card Interference (heret)			
	advanced				
	industrial	PC4 and 20 pin JTAG ports			
	application with				
	development	• 8X LEDs			
	kits and	 12V wall adapter or ATX 			
	expansion	 Voltage and Current measurement capability of supplies 			
	modules Zyng-	 DDR3 Component Memory 1GB 			
	700	 Support 32 data width 			
	or Equivalent	 16MB Quad SPI Flash 			
		IIC - 1 KB EEPROM			
		 200MHz Fixed PL Oscillator (Differential LVDS) 			
		 156.25MHz (default) I2C Programmable Oscillator (Differential LVDS) 			
		• 33.33MHz Fixed PS System Oscillator (Single-Ended CMOS)			
		Gigabit Ethernet GMII, RGMII and SGMII			
		USB OTG 1 (PS) - Host USB			
		IIC Bus Headers/HUB (PS)			
		• 1 CAN with Wake on CAN (PS)			
		 USB LIABT (PS) 			
		 3 User Push Buttons 			
		 2 User Switches 			
		• AND Headel			
		differential user defined signals)			
		Interclinial user defined signals)			
		• FINC #2-LPC connector (UGIX Transceiver, 68 single-ended or 34			

		differential user defined signals)			
		IIC HUB/Expander			
		 Dual Pmod (8 I/O Shared with LED's) 			
		 Single Pmod (4 I/O Shared with PJTAG) 			
		OR Equivalent			
18.	Field	Technical Specification (Minimum):	No	10	
	Programmable	 650MHz dual-core Cortex-A9 processor 			
	Gate array	 DDR3 memory controller with 8 DMA channels and 4 high 			
	systems for	performance AXI3 slave ports			
	industrial	High-bandwidth peripheral controllers: 1G Ethernet, USB 2.0, SDIO			
	application with	 Low-bandwidth peripheral controller: SPI, UART, CAN, I2C 			
	development	 Programmable from JTAG, Quad-SPI flash, and micro SD card 			
	kits and	Artix-7 family programmable logic			
	expansion	• 13,300 logic slices, each with four 6-input LUTs and 8 flip-flops			
		630 KB of fast block RAM			
	- Zl	• 4 clock management tiles, each with a phase-locked loop (PLL) and			
	or Equivalent	mixed-mode clock manager (MMCM)			
		220 DSP slices			
		 On-chip analog-to-digital converter (XADC) 			
		• 512MB DDR3 with 16-bit bus @ 1050Mbps			
		• 16MB Quad-SPI Flash with factory programmed globally unique			
		identifier (48-bit EUI-48/64™ compatible).			
		MicroSD slot			
		 Powered from USB or any 7V-15V source (see recommended 			
		products)			
		USB and Ethernet:			
		 USB-JTAG Programming circuitry 			
		USB-UART bridge			
		 USB OTG PHY (supports host only) 			
		Gigabit Ethernet PHY			
		 Electret microphone with pulse density modulated (PDM) output 			
		 3.5mm mono audio output jack, pulse-width modulated (PWM) format 			
		• HDMI sink port (input)			
		HDMI source port (output)			
		• 4 push-buttons			

		2 slide switches			
		• ZINOD LEDS			
		Two standard Prilod ports			
		Arduino/cnipki i Snield connector			
		• 49 Total FPGA I/O			
		 6 Single-ended 0-3.3V Analog inputs to XADC 			
		 4 Differential 0-1.0V Analog inputs to XADC 			
		OR Equivalent			
19.	Embedded	Technical Specification (Minimum):	No	20	
	system for	Broadcom BCM2711 Quad core Cortex-A72 (ARM v8) 64-bit SoC @			
	Hobby				
	Flectronics	• SCR DDDP/ 3200 SDPAM (depending on model)			
		• 000 LFDDR4-5200 SDRAW (depending on model)			
	Raspherry Pi /				
	or Equivalent				
		• 2 USB 3.0 ports; 2 USB 2.0 ports.			
		 Standard 40 pin GPIO header (fully backwards compatible with 			
		previous boards)			
		 2 × micro-HDMI ports (up to 4kp60 supported) 			
		 2-lane MIPI DSI display port 			
		2-lane MIPI CSI camera port			
		 4-pole stereo audio and composite video port 			
		H 265 (4kp60 decode) H264 (1080p60 decode 1080p30 encode)			
		 OpenGL ES 3.0 graphics 			
		 Micro SD cord clot for loading operating system and data storage 			
		• Micro-SD card slot for loading operating system and data storage			
		• 5V DC via USB-C connector (minimum 3A*)			
		• 5V DC via GPIO header (minimum 3A [*])			
		 Power over Ethernet (PoE) enabled (requires separate PoE HAT) 			
		 Operating temperature: 0 – 50 degrees C ambient 			
		OR Equivalent			
20.	Touch Screen	Technical Specification (Minimum):	No	5	
	For embedded				
	systems	Resolution: 800x480px			

	application	• 18-bit RGB			
	Touch Screen	7• 7 inches			
	inches Torade	• Touch Interface: I2C			
	Or equivalent	• 40 pin and 10 pin FFC cable to connect with a Carrier Board			
		Compatible with serial no 17 board (item)			
		OR Equivalent			
21.	Industrial	Technical Specification (Minimum):	No	6	
	Grade Monitor	Capacitive, Infrared, Resistive			
		• 19 inches			
		HDMII VGA DVI			
		Industrial LCD panel A grade			
		• 300nits. Up to 1000nits			
		• AC 110-240V 50/60Hz			
		Response time 5ms			
		Power consumption			
		Motal Shall Aluminum allow analogura			
		IDEE acomicos front			
		• IPop seamless from			
		• Waterproof, Dustproof			
		• Finger, Touch pen, Glove hand			
		OP Equivalent			
		OR Equivalent			
22.	Panel PC	Technical Specification (Minimum):	No	3	
		· · · · · · · · · · · · · · · · · · ·		-	
		Touch screen parameters			
		Touch screen type: Projected capacitive touch screen			
		• 19 inches			
		Theory Clicks: More than 50 million times			
		• Operating System Compatibility: Win 7/ Win 8 / Win 10/Win XP /			
		Linux /MAC /Android/CF			
		LED screen parameters			
		 Resolution: 1280*1024 			
		• Brightness: $> 250 \text{ cd/m}^2$			
		• Contrast ratio: $> 1000:1$			
		• Contrast ratio. ≤ 1000.1 • Viewing angle: $\frac{90}{90}\frac{90}{90}$			

		Power supply parameters			
		 Input Power: 110-240V AC 50/60Hz Output power: 12V 5A Overall power consumption: Less than 60W Standby power consumption: less than 0.5W Version: Android 7.1 CPU: RK3288/RK3399 RAM: 2G (4G optional) Memory: Flash 8G(16g/32g optional) Version: Window7 / Window 8 /Window 10 CPU: Intel Celeron J1900; Intel Atom x5-Z8350, Intel core I3/I5/I7 RAM: DDR3 2G/4G/8G/16G (optional) Memory: SSD 32G/64G/128G/256G HDD 500G/1T 			
23.	MATI AB	Academic Use — Individual:	No	2	
	License	 The products can be used by a single named user. The products can be activated on up to four different computers, provided that the products are only accessible to and used by that single named user. A named user may not use a product on more than two computers simultaneously. The license must be restricted to a single country of operation. Subscription: Annual 			
24.	QT License	QT for device creation: Targeted OS: Embedded Linux, UWP, Integrity, QNX, VxWork Windows, Linux, Mac, Android, IOS Subscription: Annual	No	2	
25.	Solid Works License	SOLIDWORKS Education Edition Software: Comprehensive CAD and engineering development teaching tool features 3D software plus a broad curriculum of exercises and interactive courseware for 3D mechanical CAD, design validation and data management.	No	1	
	Subscription Annual				
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	 408-Piece Mechanics Tool Set with 3-Drawer Heavy Duty Metal Box (Tool Set + Drill Combo Kit) Include Items: Contents: (1) utility knife, (20) utility knife blades, screwdriver), magnetic screwdriver, Handled screwdriver bits (6) precision screwdriver, metric hex key set, (11) SAE hex Hey set's, 6" Long nose pliers, 6" Diagonal pliers, (1) 6" combination pliers, (1) 16oz ball-pein hammer, (1) 7.5M (25ft) tape measure, (8) Metric combination wrenches: 8, 10, 11, 12, 13, 14, 15, 17mmm, (8) SAE Combination wrenches: 1/4", 5/16", 3/8", 7/16", 1/2", 9/16", 5/8", 3/4", (1) 8" Adjustable wrench, (1) stripper, (55) connector kit, (40) cable ties, (90) hardware kit, (1) 1/4" Dr. Ratchet handle, (1) 3/8" Dr. Ratchet handle, (1) 1/2" Dr. Ratchet handle, (10) 1/4" 6 points SAE dr. Sockets: 5/32", 3/16", 7/32", 1/4", 9/32", 5/16", 11/32", 3/8", 7/16", 1/2", (10)1/4" 6 points metric dr. Sockets: 4, 5, 6, 7, 8, 9, 10, 11, 12, 13mm, (10) 3/8" 6 points SAE dr. Sockets: 1/4", 5/16", 3/8", 7/16", 1/2", 9/16", 5/8", 11/16", 3/4", 13/16", (11) 3/8" 6 points metric dr. Sockets: 7, 8, 9, 10, 11, 12, 13, 14, 15, 17, 19mm, (8) 3/8" 12 points SAE dr. Sockets: 1/2", 9/16", 5/8", 11/16", 3/4", 7/8", (6) 1/2" 6 points SAE dr. Sockets: 1/2", 9/16", 5/8", 11/16", 3/4", 7/8", (6) 1/2" 6 points metric dr. Sockets: 14, 15, 17, 18, 19, 21mm (1) 1/2" X 3/8" Adapter, (1) 3/8" X 1/4" Adapter, (1) 1/4"x3" Extension bar, (1) 3/8"X3" Extension bar, (1) 3/8"X6" Extension bar, (1) 1/2"x5" Extension bar, (2) 3/8" Spark sockets: 13/16", 5/8". 				
	 Cordless Drill Combo Kit, 2-Tool Ergonomic Design: Lightweight tools designed to fit the user's needs Increased Visibility: The DCF885 features a built in Led with 20 second delay after trigger release Includes: (1) DCD771 drill/driver, (1) DCF885 1/4 inches' impact driver, (2) 20V MAX Lithium Ion 1.3 Ah battery packs, 20-volt MAX charger, and (1) kit bag 1 Handed Bit Loading: The DCF885 has a 1/4 inches' hex chuck and accepts 1 inches bit tips, Power Tool Type: Cordless High Performance Motor: The DCD771 delivers 300 Unit Watts Out 				

		(UWO) of power ability completing a wide range of applications			
		OR Equivalent			
27.	Benchtop	Type: Benchtop	No	3	
	Multimeter	0.05% basic accuracy			
		True RMS			
		Auto power off Overlead and Short circuit protection			
		DC ranges: 0.1 mV to 1000V			
		Resolution: 10 μ V to 100 mV			
		AC ranges: 200 mV, 2 V, 20V, 200 V, 750 V			
		Fused and short circuit protected			
		OR Equivalent			
28.	Medical Grade blowers for respiratory apparatus Micronel U65HN-024KS- 6 or equivalent	Technical Specification (Minimum): Electrical Measuring	No	4	
		Supply voltage range [VDC] Unit Minimum = 5 Typical 24 Maximum =			
		26.4			
		Power consumption (free blowing at nominal voltage) Maximum = 110 W			
		Pneumatic (Pressure)			
		Air flow (free blowing at nominal voltage) Typical = 440[I/min]			
		Minimum air flow at rated speed Minimum 0[l/min]			
		Stat. pressure at rated speed Typical = 100[mbar]			
		Pneumatic (Vacuum)			
		Air flow (free blowing at nominal voltage) Typical = 440 [l/min]			
		Minimum air flow at rated speed Minimum = 0 [I/min]			
		Stat. pressure at rated speed Typical = 90 [mbar]			
		Thermal			
		Maximum motor enclosure temperature [°C] Maximum = 70			

	Ambient operating temperature [°C] Minimum = -20 Typical = 25
	Maximum = 50
	Ambient storage temperature [°C] Minimum = -20 Typical = 25 Maximum
	= 50
	Motor
	Maximum speed for continuous operation Maximum = 57.000 [rpm]
	Acceleration (at nominal voltage) Typical = 400 [rpm/ms]
	Number of pole pairs Typical 1
	Terminal resistance Typical = 0.208[Ohm]
	Terminal inductance Typical = 0.014 [mH]
	Back EMF-constant Typical = 0.37 [V/Krpm]
	Torque constant Typical = 3.53[mNm/A]
	Rotor inertia Typical = 1.2 [g/cm2]
	Ambient
	Protection class Typical = IP10
	Relative humidity Minimum = 10 Maximum = 95 [%RH]
	Oxygen resistence Maximum = 100 [%]
	Life Time
	L10 Maximum 20'000[h]
	Acoustics
	Acoustic level Maximum = 47 [dB(A)]
	Mechanical
	Weight Typical = 240 [gr]
	Balancing class Typical = G < 2.5 [mm/s]
	Impeller Inertia Typical = 5.34 [gcm2]

		OR Equivalent			
29.	Blower Controller for	Technical Specification (Minimum):	No	4	
	respiratory apparatus	Weight :170 g			
		MOTOR			
	Maxon EPOS2 24/5. Digital	DC motors up to 120 W			
	positioning	EC motors up to 120 W			
	controller Or equivalent	SENSOR			
		Without sensor (DC motors) Yes			
		Digital incremental encoder (2-channel, differential) Yes			
		Digital incremental encoder (3-channel, differential) Yes			
		Digital Hall sensors (EC Motors) Yes			
		OPERATING MODES			
		Current controller			
		Yes			
		Speed controller (closed loop) Yes			
		Position controller Yes			
		ELECTRICAL DATA			
		Operating voltage V(min.) 11 V			
		Operating voltage V(max.)24 V			
		Logic supply voltage V(min.)optional 11 V			
		Logic supply voltage V(max.)optional 24 V			
		Max. output voltage (factor * V)0.9			
		Max. output current I 10 A			

Max. time of peak output current I 1 s
Continuous output current I 5 A
PWM clock frequency of powerstage 50 kHz
Sampling rate PI current controller 10 kHz
Sampling rate PI speed controller 1 kHz
Sampling rate PID positioning controller 1 kHz
Max. efficiency 92 %
Max. speed (DC) 100000 rpm
Max. speed (EC; 1 pole pair) blockcommutation100000 rpm
Max. speed (EC; 1 pole pair) sinusoidal commutation 25000 rpm
Built-in motor choke per phase 15 µH
INPUTS
Hall sensor signals H1, H2, H3
Encoder signals A, A, B, B, I, I\
Max. encoder input frequency 5 MHz
Digital inputs 6
Functionality of digital inputs: limit switch, reference switch, general
purpose, enable, quickstop, step/direction set value, master encoder,
position marker
Analog inputs 2
Resolution, range, circuit 12-bit, 0+5V
Functionality of analog inputs set value, general purpose
DIP switch 8
Functionality of the DIP switch CAN Node-ID, CAN-Bus Termination
OUTPUTS

	Digital outputs 4			
	Functionality of digital outputs holding brake, general purpose, position			
	compare, ready			
	VOLTAGE OUTPUTS			
	Hall sensor supply voltage +5 VDC, max. 30 mA			
	Encoder supply voltage +5 VDC, max. 100 mA			
	Auxiliary output voltage +VCC , max. 1300 mA			
	INTERFACE RS232 Yes			
	USB 2.0 (full speed) Yes			
	CAN Yes			
	CANopen Slave			
	CANopen application layer DS-301			
	CANopen frameworks DSP-305			
	CANopen profiles motion control DSP-402			
	Gateway function RS232-to-CAN Yes			
	Gateway function USB-to-CAN Yes			
	DISPLAY			
	Status indicator "Ready" green LED			
	Status indicator "Error" red LED			
	PROTECTIVE FUNCTIONS			
	Protective functions: current limit, overcurrent, excess temperature,			
	undervoltage, overvoltage, voltagetransients, short-circuits in the motor			
	cable			
	AMBIENT CONDITIONS			
	Temperature – Operation (min.) -10 °C			
		1	1	1

Temperature – Operation (max.) 55 °C		
Temperature – Extended Range +55…+83°C, Derating: -0.179 A/°C		
Temperature – Storage (min.) -40 °C		
Temperature – Storage (max.) 85 °C		
Humidity (non-condensing) (min.) 5 %		
Humidity (non-condensing) (max.) 90 %		
MECHANICAL DATA		
Weight 170 g		
Dimension (length) 105 mm		
Dimension (width) 83 mm		
Dimension (height) 24 mm		
Mounting Flange for M3 screws		
SOFTWARE		
Installation program EPOS Setup		
Graphical User Interface EPOS Studio		
Operating system Windows 10, 8, 7, Windows XP SP3		
Windows DLL for PC 32-/64-bit		
PC master IXXAT, Vector, National Instruments, Kvaser, NI-XNET		
Programming examples MS Visual C#, MS Visual C++, MS Visual Basic,		
MS Visual Basic.NET, Borland C++,		
Borland Delphi, NI LabView, NI LabWindows/CVI		
Linux Shared Object Library X86 32-/64-bit, ARMv7		
Programming example C++ (Eclipse Project)		
IEC 61131-3 library for CAN		
Master		

Beckhof, Siemens/Helmholz, VIPA		
maxon library for NI SoftMotion National Instruments Compact Rio		
FUNCTIONS		
CANopen Profile Position Mode Yes		
CANopen Profile Velocity Mode Yes		
CANopen Homing Mode Yes		
Position Mode Yes		
Interpolated Position Mode (PVT) Yes		
Velocity mode Yes		
Current mode Yes		
Master Encoder Mode Yes		
Step/Direction Mode Yes		
Analog set value Yes		
Path generator with		
sinusoidal/trapezoidal profiles		
Yes		
Position Control Feed Forward Yes		
Velocity Control (Feed Forward) Yes		
Position Marker / Touch Probe Yes		
Quickstop Yes		
Enable Yes		
Position Compare Yes		
Control of holding brakes Yes		
Advanced automatic control settings Yes		
OR Equivalent		

30.	Respiratory Module for	Technical Specification (Minimum): VENTILATION MODES	No	2	
	medical grade	Ventilation mode: PC-CMV PC (Pressure Control),VC-CMV VC (Volume			
	systems	Control), PC-SIMV SIMV(PC), VC-SIMV SIMV(VC), PC-SIMV+ Bi-Level			
	Macawi full	Ventilation, PC-BIPAP, PC-ACV ACV(PC), VC-ACV ACV(VC), Spn-			
	respiratory	CPAP CPAP, CFLOW Continuous Flow at pre-set O2 concentration			
	system or equivalent	REAL-TIME SIGNALS			
		Airway Pressure: Patient Flow, Patient Volume,			
		VENTILATION MODE OPTIONS			
		NIV (Non Invasive Ventilation), PS (Pressure Support) on top of PEEP			
		PSV, PCVR (Pressure Controlled Volume Regulation) PRVC, AutoFlow,			
		AVAPS, Volume Guarantee, HPO & LPO High Pressure Oxygen & Low			
		Pressure Oxygen			
		MEASUREMENTS			
		VT Tidal Volume (in- & exp.) [mand. & spont.], MV Mandatory Volume			
		(in- & exp. & tot.) [mand. & pont.], RR Respiratory Rate [mand. & spont.],			
		Ppeak Peak Pressure (PIP), Pplat Plateau Pressure, PEEP Positive			
		End-Expiratory Pressure, MAP Mean Airway Pressure, FiO2 Fractional			
		Inspired Oxygen, Vleak Leakage volume per breath			
		VENTILATION SETTINGS RANGE			
		VT 2 - 2000 mL , RR 3 - 200 /min, Pinsp, PS Low (Pressure Support) 1 -			
		90 mbar, Pressure Support 1 - 90 mbar , PEEP 0 - 40 mbar, Insp Flow			
		5000 - 100000 mL/min for VC with plateau, Ti, Te			
		and Tramp 150 - 30000 ms (Ti & Te) 60-30000 ms (Tramp) FiO2 21 -			
		100 Vol.%			

VENTILATION MANEUVERS	
Inspiratory Hold Manual start or generation of prolonged inspiration time	
PERFORMANCE	
Maximum Pressure 100 mbar at sea level (> 80 mbar at 3000m altitude),	
Maximum Flow > 220 L/min	
ADDITIONAL FUNCTIONALITY	
Distal and Proximal flow and pressure sensor support	
OTHER RELATED FUNCTIONALITY	
Proximal patient flow measurement (including purge system), Proximal	
airway pressure measurement (including purge system), Triggering	
functionality in all modes on Flow and or Pressure, Leakage	
compensation up to > 50 L/min, Nebulizer control output (driver for	
valve), Compensation of compressible volume For Volume controlled	
modes, Oxygen sensor interface Galv. Analog sensor or paramagnetic	
digital sensor, System test and calibration functionality, External Safety	
Valve	
ADDITIONAL VENTILATION MODES	
PC-AMV Assisted Manual Ventilation, Neonatal T-piece resuscitation,	
PC-APRV Pressure controlled - Airway Pressure Release Ventilation,	
PC-MMV Pressure controlled - Mandatory Minute Ventilation	
ADDITIONAL VENTILATION MANEUVERS	
PS High (Pressure Support) PS on top of inspiratory pressure,	
Recruitment Generate a fixed number of elevated pressure strokes, PPS	
Proportional Pressure Support, P0.1 measurement figure for weaning	
purposes, Tube Compensation Automatic Tube Compensation	

(inspiratory and/or expiratory),Sigh Generate sigh maneuver at set time
interval, Expiratory Hold Manual generation of prolonged expiration time
ADDITIONAL MEASUREMENTS
Flowpeak_insp ,Inspiratory Peak Flow, Flowpeak_exp Expiratory Peak
Flow, Pmin_exp Expiratory Minimum Pressure, P0.1 Negative pressure
after 100 ms no inspiratory support, RSBI Rapid Shallow Breathing
Index, PTP Pressure Time Product, Cstat Static Compliance, Rinsp
Inspiratory Resistance, AutoPEEP Intrinsic PEEP, Tracheal Pressure
Derived Tracheal Pressure, Advanced software
ENVIRONMENTAL OPERATING CONDITIONS
Operating temperature -20 - + 55degrees C, Relative air humidity 5 -
95% R.H., Air Pressure 500 - 1100 hPa., Module lifetime expectancy >
30.000 hours At moderate Ventilation level, Noise generation < 40 dB At
a pressure of 40 cmH2O, ISO 3744, Pinsp = 20 mbar, PEEP = 5 mbar,
Tslope = 200ms, RR = 12 /min at Rp5C20
ELECTRICAL OPERATING CONDITIONS
Power Supply Voltage 24V DC ±10%, Peak current up to 5A at 24V max.
during 200 ms atmaximum insp. pressure setting, Continuous current up
to 2.5A (during insp.) at 24V at maximum inspiratory pressure setting,
Nominal Power consumption 5 - 30 VA at 24V depending on Ventilation
settings and patient
MODULE PROPERTIES
Envelope dimensions 120 x 90 x 185 mm (standard)
Volume < 2L, Module Weight < 850 gram
Also include the evaluation kit

31.	Full Set	Package Must include (minimum):	No	4	
	Hexacopter	1XTarot FY690S Full 6 axle Carbon Aircraft Frame 3K Folding			
	Drone 6-axle	Hexacopter 680mm FPV TL68C01			
	Aircraft Kit	6X750KV Brushless Disk Motor			
	750KV Motor	6XHOBBYWING Platinum-30A-Pro 2-6S 30A Speed Controller ESC			
	GPS APM 2.8	3X12x5.5 3K Carbon Fiber Propeller			
	Flight Control	1XAPM2.8 APM 2.8 Multicopter Flight Controller 2.5 2.6 Upgraded Built-			
	, C	in Compass			
		1x6M GPS with Compass L5883 25cm Cable			
		5x10cm Servo Extension Lead Wire Cable MALE TO MALE KK MK			
		MWC flight control Board For RC Quadcopter			
		1XDJI GPS Folding Antenna Mount Holder Metal			
		1X8S-5A 5A U-BEC UBEC Input 9-30V 3-8S Lipo battery 8-24Nimh R7			
		18x3.5mm Bullet Connector (banana plug)			
		1xHook & Loop Fastening Tape			
		1xT Plug Male Connector Silicone Wire With 11.5CM 14awg			
		1xIMAX RC B3 Pro Compact Balance Charger			
		1x 11.1V 2200MAH 30C 3S1P battery			
		1XRadioLink AT10 2.4GHz 10CH Remote Control System			
32.	800*480 FPV	Specification (minimum)	No	2	
	Goggles				
	Combo Kit with	Optics			
	32CH RX	FOV (field of view): 30° diagonal (the same plastic optics as DOMV2)			
	SpiroNET ANT	Interpupillary Distance (IPD): 59 to 69 mm (adjustable)			
		Optional Diopter Lens Inserts: -2, -4, -6 dpt			
	Fatshark				
	Dominator V3	Display			
	with FSV2442	800 x 480 WVGA LCD			
	or equivalent	Polarized LED backlight			
		NTCS/PAL auto selecting			
		Side/Side 3D			
		Input HD Port 16:9			
		Video 4:3 horizontally stretched			
		(Current A/C chip only supports to 720p 50/60 Hz, could be upgraded to			
		1080p in the future)			
		Audio: Stereo			

		NTSC/PAL auto switching. Integrated DVR records your analog footage and has playback function			
		that may assist in lost model recovery.			
		If the power is disconnected or the battery runs flat, the DVR will auto-			
		save any recorded video, preventing a corrupted card or loss of data.			
		Warning: Exposing the lens to direct sunlight will result in LCD damage.			
		Package Included:			
		1 x FPV Goggle			
		1 x 32 channel Race Band receiver			
		1 x FSV Battery and its Case			
		1 x Zipper carry case			
		1 x 3m AV Cable			
		1 x Manual			
33.	5G8 5.8GHz	SPECIFICATIONS (minimum):	No	10	
	Mini FPV	Operating Voltage: 2S - 6S			
	Transmitter	Supply current: 600mA			
	with antenna	Operating Temperature: watch for normal airflow			
		Audio carrier Frequency: 6.5 MHz			
	Team	Video Input Impedance: 75 Ohm			
	Blacksheep	Weight: 5g (with SMA, without antenna)			
	TBS Unify Pro	Antenna Connector: SMA Female Socket with screw mounting holes,			
	Or equivalent	U.FL to VTx			
		Video Format: NTSC/PAL			
		Output Power: 13dBm (25mW), 23dBm (200mW)			
		Antenna: 5.8G Spironet Antenna			
34.	FPV Receiver	Specification (minimum):	No	10	
	for UVC OTG	Frequency : 5645MHz~5945MHz			
	Smartphone	Resolution : 640*480 30fps			
	Android Tablet	Working Current : USB 5V 190mA			
	PC Monitor VR	Connector : RP-SMA			
	Headset	Working Temp. : -10~65°C			
		Please calibrate it before use			
	Skydroid	Please calibrate it in open area, and keep away from transmitter more			
	5.8Ghz 150CH	than 30m. Long press the menu button and power on receiver, enter into			
	True Diversity	calibration mode.			
	or Equivalent				

35.	Mini FPV	Specification (minimum):	No	10	
	Camera PAL	Image Sensor: 1/3" Super HAD II CCD			
	with MIC	Horizontal Resolution: 600TVL,4:3			
	Support OSD	Lens: 2.5mm 130° / 2.3mm 150°/ 2.1mm 165° (Optional)			
	RunCam Swift	Signal System: PAL			
	2 600TVL or	Integrated OSD: YES			
	equivalent	Integrated MIC: YES			
		S/N Ration>60dB (AGC OFF)			
		Electronic Shutter Speed: PAL:1/50~100,000; NTSC:1/60~100,000			
		AutoGain Control (AGC): YES			
		Back light compensation (BLC): YES			
		Power DC 5 to 36V			
		Net weight 14g			
		Dimensions 28.5mm * 26mm * 26mm			
36.	PC for AI	Processor	No	4	
	Applications	Intel® Xeon® Silver 4110 (2.10GHz, 8 cores, 11MB Cache)			
	ThinkStation	Operating System			
	920	Windows 10 Pro for Workstations 64			
	Workstation or				
	equivalent	Memory			
		8GB DDR4 2666MHz ECC RDIMM			
		Graphics			
		INVIDIA QUADIO POZU 12GB (IVIINI DPX4)			
		TTP Hard Drive 7200PDM 2.5" SATA2			
		TID Halu Drive, 7200RFW, 5.5, SATAS			
		Ontical Drive			
		No 1st Ontical Drive Selected			
		Warranty			
		3 Year On-site			
		Network Card			
		2x port Integrated Ethernet			

		Keyboard			
		USB Traditional Keyboard Black English			
		COD Traditional Royboard Black English			
		Pointing Dovice			
		Folling Device			
		USB Calliope Mouse Black			
		Form Factor			
		Tower 92% Power 1400W			
		M.2 Storage Card			
		Upgradable			
37.	Heavy Robot	Specification (minimum):	No	5	
	Chassis	All-Terrain			
		Anodized Aluminum Body			
	T'Rex Tank	Anodized Zinc Tracks, Struts, and Wheels			
	Chassis	2x 12V DC motors with all metal gearboxes			
	Or equivalent	Motor Specifications:			
	••••	Typical Voltage: 12V			
		No Load Current: 1.3A			
		Typical Current: 4A			
		Stall Current: 11A (Measured using a 3S 5000mAh LiPo battery)			
		70mm (2.75") Clearance with Low Center of Gravity			
		Pomovable Front and Top Papels with Quick Spring Polease			
		Removable From and Top Fahels with Quick Spring Release $255 \times 175 \times 120 \text{ mm} (14" \times 6.9" \times 5")$			
20	Llavan ad Daha	$\frac{555 \times 175 \times 15011111 (14 \times 0.6 \times 5)}{1100000000000000000000000000000000000$	Na	4	
38.		LINCIUSION (MINIMUM):	INO	4	
		3X 3DOF T-Hex Leg pairs			
	Only)	IX I-Hex body			
		ox servo extender cables			
	Lynxmotion I-				
	Hex 3DOF or				
	equivalent				
39.	STM32H7	Frequency: 400Mhz	No	20	
	Development	Package: LQFP100			
	Board	RAM: 1024KB			
		Flash: H750VB: 128KB H743VI: 2048KB (2M)			
		OLED interface – Plug and Play			
		0.96 inch/ 1.3 inch OLED			
		Data storage: W25Q64 (QPSI driver)			

		High speed crystal: 25 MHz			
		Low frequency crystal: 32.768K			
		Power + Programmable LED Lights			
		2 users and reset button			
		All CPU – IO Leads			
		2.54MM integer double spacing pin			
40.	Sensors Kit	Kit Listing:	No	5	
		White LED Module * 1			
		RGB LED Module *1			
		3W LED Module * 1			
		Traffic Light Module (Black and Eco-friendly) *1			
		Active Buzzer Module *1			
		Passive Buzzer Module *1			
		Digital Push Button Module *1			
		Collision Sensor *1			
		Line Tracking Sensor *1			
		Infrared Obstacle Avoidance Sensor *1			
		Photo Interrupter Module * 1			
		Hall Magnetic Sensor *1			
		Knock Sensor Module *1			
		Digital Tilt Sensor * 1			
		Capacitive Touch Sensor *1			
		Flame Sensor *1			
		Reed Switch Module *1			
		PIR Motion Sensor *1			
		Analog Temperature Sensor *1			
		Analog Rotation Sensor *1			
		Photocell Sensor *1			
		Analog Sound Sensor *1			
		Water Sensor *1			
		Soil Humidity Sensor *1			
		Analog Gas Sensor *1			
		Analog Alcohol Sensor *1			
		Steam Sensor *1			
		Analog Piezoelectric Ceramic Vibration Sensor *1			
		Voltage Sensor *1			
		Thin-film Pressure Sensor (Black and Eco-friendly) *1			

		TEMT6000 Ambient Light Sensor *1			
		GUVA-S12SD 3528 Ultraviolet Sensor *1			
		Digital IR Receiver Module *1			
		Digital IR Transmitter Module *1			
		Pulse Rate Monitor Module *1			
		Joystick Module * 1			
		Rotary Encoder Module *1			
		5V Single Relay Module *1			
		LM35 Linear Temperature Sensor *1			
		DHT11 Temperature and Humidity Sensor *1			
		Magical Light Cup Module *2			
		APDS-9930 Attitude Sensor Module *1			
		ALS Infrared LED Optical Proximity Detection Module *1			
		MMA8452Q Module Triaxial Digital Acceleration Tilt Sensor * 1			
		keyestudio 9G Servo Motor *1			
		HC-SR04 Blue Ultrasonic Sensor *1			
		Keyestudio 0802 LCD module 5V blue screen(with backlight) *1			
		keyestudio I2C 8x8 LED Dot Matrix *1			
41.	Google Cloud	On-board FTDI2232 IC for 4-wire JTAG debugging	No	4	
	loT	Various commercial and free IDE options for JTAG debugging and			
	Development	software development			
	Kit for creating	Arduino connector to extend kit and add shields			
	Internet of	Open schematics and layout files			
	Things (IoT)	Eclipse based IDE for single-step JTAG debugging			
		UART-AT commands to connect T4-G-Q-4020 to MCU/CPU			
	T4-G-Q-4020	Eight sensors and actuators on-board:			
	or equivalent	Ambient light luminosity			
		3D accelerometer			
		3D gyroscope/rotation			
		3D magnetic field			
		Humidity			
		Pressure			
		PIR sensor			
		Out-of-box drivers for sensors in demo applications			
		iviscellaneous neaders, test-points for power measurement, direct			
40		connect to pattery, boot-configuration, and other measurements	N -	4	
42.	ARM-based lo	Electronic components (Minimum):	INO	4	

	Kit for Cloud	1x Photo Cell					
	IoT Core	2x Breadboard Tri	m Potentiometer				
		5x 10K 5% 1/4W I	Resistor				
		5x 560 ohm 5% 1/	4W Resistor				
		2x Diffused 10mm	Blue LED				
		1x Electrolytic Ca	pacitor - 1.0uF				
		1x Ceramic Capa	citor - 0.1uF				
		2x Diffused 10mm	Red LED				
		2x Diffused 10mm	Green LED				
		3x 12mm Tactile S	Switches				
43.	Injection	Technical Specif	ication (minimun	n):	No	1	
	Molding		Υ.	,			
	Machine	Power	0.5kw				
		Shot weight	20grams				
		Nozzle hole	2mm				
		Diameter					
		Motor Accuracy	0.002mm				
		Cooling Type	Water				
		Power source	AC220V				
			200*145mm*14				
		Max Mold size	5mm				
		Heating Band	DC36V				
		Power					
			PC.PS.PP.ABS				
		Material	,TPU				
			900mm*210mm				
		Machine Size	*350mm				
		Machine weight	120kgs				
		5		1			
		High accuracy (ca	n make small part	ts weight<0.01g micro product)			
		(Leading technolo	gy)	с с і <i>,</i>			
		1): PID temperatu	re control±1°C				
		2): Mold clamping	accuracy 0.001m	m			
		3): Shot weight ac	curacy 0.001g				
		4): Shot peak pres	sure 1kg				
			Ŭ				
		High efficiency: 3.	5s shaping cycle				

	Traditional hydraulic press: Shot speed: 160~200mm/s Molding cycle :7~10 /s			
Total				

Firm Name:

Signature:

Name:

Designation:

Tender No Name of the Firm	
Firm Address	
Date	
Telephone No	
E-Mail	

Τo,

DD SCM Office NUTECH University I-12, Main IJP Road, Islamabad.

Dear Sir

1. I / We hereby offer to supply to the NUTECH University the stores detailed in schedule to the tender inquiry or such portion thereof as you may specify in the acceptance of tender at the price offered against the said schedule and further agree that this offer will remain valid up to 90 days after opening of Financial offer and will not be withdrawn or altered in terms of rates quoted and the conditions already stated therein or on before this date. I / we shall be bound by a communication of acceptance to be dispatched within he prescribed time.

2. I / we have understood the instructions to Tenders and General Conditions Governing Contract available at NUTECH website and have thoroughly examined the specifications / drawing and / or patterns quoted in the schedule here to and am/are fully aware of the nature of the stores required and my/ our offer is to supply stores strictly in accordance with the requirements.

Yours Faithfully.

(Signature of Tenderer) Designation Date:

Individual signing tender and / or other documents connected with a contract must be signed by principal authorized rep/ OEM rep/ Authorized partner firm rep.

SPECIMEN FOR "ADVANCE PAYMENT BANK GUARANTEE"

Guarantee No:	Date	Amount:	Valid upto:	_
In Favour of:				
National Univers	ity of Technology	(NUTECH), IJP Road	, I-12, Islamabad	
Subject: <u>Advan</u>	<u>ce Payment Bar</u>	ik Guarantee		
Contract No:	DATI	ED		
Dear Sir,				
1. We <u>[Name</u>	of Guarantor] ur	nderstand that you hav	e entered into contract w	rith <u>M/S [Name of</u> Firm]
(hereinafter cal	led Our Client),	for provision of [Name	e of Stores]. And as pe	r the above mentioned

Contract, you are liable to pay to Our Client an amount of [Amount of Guarantee] in advance, which shall be released against a Bank Guarantee. 2. Bank & seller firm shall inform your office regarding termination of the validity of this bank Guarantee one clear month before the actual expiry date of this Bank Guarantee.

3. Now, we hereby irrevocably undertake to immediately make payment on to your orders, merely upon receipt of your first written notice, an amount not exceeding [Amount of Guarantee] that may be claimed by you at your own discretion without it being necessary for you to prove or even assert to the Bank any default whatsoever of Our Client under the Contract.

4. Claims against this Guarantee shall be lodged on us through written request/s on your proper Letter Head. Unless claims are not presented on or before the Validity Date, all rights and benefits under this guarantee shall be forfeited and we shall be released from all claims, demands or liabilities of any kind whatsoever.

5. This Guarantee shall remain in force up to the above mentioned Validity Date which can however, be extended upon request of Our Client.

Yours faithfully,

Signature:_____

Name:

Designation:

Bank Stamp:

"SPECIMEN FOR BANK GUARANTEE AGAINST PERFORMANCE/WARRANTY GUARANTEE"

Guarantee No: _____Date_____ Amount: _____ Valid upto: _____

In Favour of: National University of Technology (NUTECH), IJP Road, I-12, Islamabad

Subject: In compliance with terms of Performance/Warranty Guarantee Bank Guarantee

Contract No: _____ dated_____

Dear Sir,

1. Whereas your good-self have entered into Contract No__dated_with M/s [Firm Name] Located at [Firm Address], Herein after referred to as our customer and that one of the conditions of the Contract is submission of Bank Guarantee by our customer to your good-self for a sum of [Amount].

2. Incompliance with this stipulation of subj contract, we hereby agree and undertake as under:-

- a. To pay to you unconditionally on demand and / or without any reference to our Customer an amount not exceeding the sum of [Amount] as would be mentioned in your written Demand Notice.
- b. To keep this Guarantee in force till [Validity Date].
- c. That the validity of this Bank guarantee shall be kept two clear year ahead of the original / extended delivery period or the warrantee of the stores which so ever is later in duration on receipt of information from your office. Our liability under this Bank Guarantee shall cease on the closing of banking hours on the last date of validity of this Bank Guarantee. Claim received there after shall not been entertained by us whether you suffer a loss or not. On receipt of payment under this Guarantee, this documents i.e., Bank Guarantee must be clearly cancelled, discharged and returned to us.
- d. That we shall inform your office regarding termination of the validity of this bank
 Guarantee on clear month before the actual expiry date of this Bank
 Guarantee.
- e. That with the consent of our customer you may amend / alter any term / cause of the contractor add / delete any term / clause to / from this contract without making any reference to us. We do not reserve any right to receive any such amendment / alternation or addition / deletion provided such like actions do not increase our monetary liability under this Bank Guarantee which shall be limited only [Amount].
- f. That the bank guarantee herein before given shall not be affected by any change in the constitution of the Bank or Customer / Supplier or Vendor.

g. That this is an unconditional Bank guarantee, which shall been cashed on sight on presentation without any reference to our Customer / Supplier or Vendor.

Signature_____

Name_____

Desig_____

Bank Stamp_____

Note: No changes in the above given BG format shall be accepted.

"SELLER'S WARRANTY CERTIFICATE"

(To be provided on stamp paper) Dated:

Validity years from the date of final acceptance of the Stores.

Contract No: _____

We hereby guarantee that we are the genuine and original Source of provisioning the Stores to our Buyer. We also undertake that nothing in the manufacturing of these Stores has been obtained through unauthorized means.

1. We hereby warrant and undertake that the Stores and all the associated spares/ accessories supplied under the terms and conditions of the above Contract, are:

- a. brand new, complete in all respects, possessing good quality and standard workmanship; and
- b. liable for replacement/rectification free of charge, if during the Warranty period the same are found defective before or under normal use or these do not remain within the limits and tolerances stated under the specifications or in any way not in accordance with the terms of this Contract. All expenses incurred in removal, re-provisioning and reinstallation of such defective Stores or their parts shall also be borne by us.

2. The Warranty shall remain valid for a period of _____ years from the date of final acceptance of the Stores.

Signature & Stamp

Name & CNIC

Designation: Date:

**Sellers warranty must be provided by the Seller (firm) on Rs 100 stamp paper along with bank guarantee/CDR/Pay Order without changing a word. BG with additional clauses will be rejected.

CHECK LIST

(This checked list must be attached with your technical offer, duly filled and

Signed by authorized signatory)

Tender No_____

Date_____

1	Tender Processing	a. Tender processing fee ref no					
	Fee	b. Bank	b. Bank				
		c. Amount	c. Amount				
2	EM/ Bid Bond	a. EM/ Bid Bond ref no	a. EM/ Bid Bond ref no				
		b. Bank	_				
3	Form Annex A, A-1,	B and C signed by Authorized	Yes	No			
	Signatory						
4	Offering specification	n of items as per IT	Yes	No			
5	Quoted Currency as	per IT	Yes	No			
6	Accounting unit/Qty	Accounting unit/Qty as per IT Yes					
7	Delivery Schedule a	s per IT	Yes	No			
8	Country of origin of s	store		1			
9	Name of OEM:						
10	Original Performa in	voice (Mandatory)	Yes	No			
11	Certified that there is	s no Deviation from IT conditions/	Yes	No			
	there is deviation fro	m IT condition as per fol details					
12	2 Blacklisting certificate. Yes			No			
13	Verifiable OEM Cert	No					
14	Warranty Period as	No					
15	ATPs provided	No					

Note: Fill and/or mark Yes/No where required

Signature of Firm Auth Signatory